24-Bit, 192-kHz Sampling, Enhanced Multi-Level ΔΣ, Eight-Channel Audio Digital-to-Analog Converter

Check for Samples: PCM1690-Q1

FEATURES

- **Qualified for Automotive Applications**
- **24-Bit Delta-Sigma DAC**
- **8-Channel DAC:**
  - **High Performance: Differential, f_S = 48 kHz**
  - **THD+N: –94 dB**
  - **SNR: 113 dB**
  - **Dynamic Range: 113 dB**
  - **Sampling Rate: 8 kHz to 192 kHz**
  - **System Clock: 128 f_S, 192 f_S, 256 f_S, 384 f_S, 512 f_S, 768 f_S, 1152 f_S**
  - **Differential Voltage Output: 8 V_{PP}**
  - **Analog Low-Pass Filter Included**
  - **4x/8x Oversampling Digital Filter:**
    - **Passband Ripple: ±0.0018 dB**
    - **Stop Band Attenuation: –75 dB**
  - **Zero Flag**
- **Flexible Audio Interface:**
  - **I/F Format: I²S™, Left-/Right-Justified, DSP, TDM**
  - **Data Length: 16, 20, 24, 32 Bits**
- **Flexible Mode Control:**
  - **3-Wire SPI™, 2-Wire I²C™-Compatible Serial Control Interface, or Hardware Control**
- **Multi Functions via SPI or I²C I/F:**
  - **Audio I/F Format Select: I²S, Left-Justified, Right-Justified, DSP, TDM**
  - **Digital Attenuation and Soft Mute**
  - **Digital De-Emphasis: 32 kHz, 44.1 kHz, 48 kHz**
  - **Data Polarity Control**
  - **Power Down**
- **Multi Functions via H/W Control:**
  - **Audio I/F Format Select: I²S, TDM**
  - **Digital De-Emphasis Filter: 44.1 kHz**
- **Analog Mute by Clock Halt Detection**
- **External RESET Pin**
- **Power Supplies:**
  - **5 V for Analog and 3.3 V for Digital**
- **Package: HTSSOP-48**
- **Operating Temperature Range:**
  - **–40°C to +85°C**

APPLICATIONS

- **Blu-ray™ DVD Players**
- **HD DVD Players**
- **AV Receivers**
- **Home Theaters**
- **Car Audio External Amplifiers**
- **Car Audio AVN Applications**

DESCRIPTION

The PCM1690-Q1 is a high-performance, single-chip, 24-bit, eight-channel, audio digital-to-analog converter (DAC) with differential outputs. The eight-channel, 24-bit DAC employs an enhanced, multi-level delta-sigma (ΔΣ) modulator and supports 8-kHz to 192-kHz sampling rates and a 16-/20-/24-/32-bit width digital audio input word on the audio interface. The audio interface of the PCM1690-Q1 supports the time-division-multiplexed (TDM) format in addition to the standard I²S, left-justified, right-justified, and DSP formats.

The PCM1690-Q1 can be controlled through a three-wire, SPI-compatible interface, or two-wire, I²C-compatible serial interface in software, which provides access to all functions including digital attenuation, soft mute, de-emphasis, and so forth. Also, hardware control mode provides a subset of user-programmable functions through two control pins. The PCM1690-Q1 is available in a 12-mm × 8-mm (12-mm × 6-mm body) HTSSOP-48 package.

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION(1)

PRODUCT	PACKAGE-LEAD	PACKAGE DESIGNATOR	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA, QUANTITY
PCM1690-Q1	HTSSOP-48	DCA	–40°C to +85°C	PCM1690Q	PCM1690IDCARQ1	Tape and Reel, 2000

(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

ABSOLUTE MAXIMUM RATINGS(1)

Over operating free-air temperature range (unless otherwise noted).

PARAMETER	PCM1690-Q1	UNIT
Supply voltage: VCC1, VCC2	–0.3 to +6.5	V
Supply voltage: VDD	–0.3 to +4.0	V
Ground voltage differences: AGND1, AGND2, DGND	±0.1	V
Supply voltage differences: VCC1, VCC2	±0.1	V
Digital input voltage: RST, TEST, MS, MC, MD, SCKI, AMUTEI, AMUTEO	–0.3 to +6.5	V
Digital input voltage: BCK, LRCK, DIN1/2/3/4, MODE, ZERO1, ZERO2	–0.3 to (VDD + 0.3) < +4.0	V
Analog input voltage: VCOM, VOUT1–8±	–0.3 to (VCC + 0.3) < +6.5	V
Input current (all pins except supplies)	±10	mA
Ambient temperature under bias	–40 to +125	°C
Storage temperature	–55 to +150	°C
Junction temperature	+150	°C
Lead temperature (soldering, 5s)	+260	°C
Package temperature (IR reflow, peak)	+260	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Over operating free-air temperature range (unless otherwise noted).

PARAMETER		PCM1690-Q1			UNIT
		MIN	TYP	MAX	
Analog supply voltage, VCC		4.5	5.0	5.5	V
Digital supply voltage, VDD		3.0	3.3	3.6	V
Digital Interface		LVTTL compatible			
Digital input clock frequency	Sampling frequency, LRCK	8		192	kHz
	System clock frequency, SCKI	2.048		36.864	MHz
Analog output voltage	Differential		8		V_{PP}
Analog output load resistance	To ac-coupled GND	5			kΩ
	To dc-coupled GND	15			kΩ
Analog output load capacitance				50	pF
Digital output load capacitance				20	pF
Operating free-air temperature	PCM1690-Q1 consumer grade	–40	+25	+85	°C

ELECTRICAL CHARACTERISTICS: Digital Input/Output

All specifications at T_A = +25°C, VCC1 = VCC2 = 5 V, VDD = 3.3 V, f_S = 48 kHz, SCKI = 512 f_S, 24-bit data, and Sampling Mode = Auto, unless otherwise noted.

PARAMETER		TEST CONDITIONS	PCM1690-Q1			UNIT
			MIN	TYP	MAX	
DATA FORMAT						
Audio data interface format				I^2S, LJ, RJ, DSP, TDM		
Audio data word length				16, 20, 24, 32		Bits
Audio data format				MSB first, twos complement		
Sampling frequency	f_S		8	48	192	kHz
System clock frequency		128 f_S, 192 f_S, 256 f_S, 384 f_S, 512 f_S, 768 f_S, 1152 f_S	2.048		36.864	MHz
INPUT LOGIC						
Input logic level	V_{IH} (1) (2)		2.0		VDD	VDC
	V_{IL} (1) (2)				0.8	VDC
Input logic level	V_{IH} (3) (4)		2.0		5.5	VDC
	V_{IL} (3) (4)				0.8	VDC
Input logic current	I_{IH} (2) (3)	V_{IN} = VDD			±10	µA
	I_{IL} (2) (3)	V_{IN} = 0 V			±10	µA
Input logic current	I_{IH} (1) (4)	V_{IN} = VDD		+65	+100	µA
	I_{IL} (1) (4)	V_{IN} = 0 V			±10	µA
OUTPUT LOGIC						
Output logic level	V_{OH} (5)	I_{OUT} = –4 mA	2.4			VDC
	V_{OL} (5) (6)	I_{OUT} = +4 mA			0.4	VDC
REFERENCE OUTPUT						
VCOM output voltage				0.5 × VCC1		V
VCOM output impedance				7.5		kΩ
Allowable VCOM output source/sink current					1	µA

(1) BCK and LRCK (Schmitt trigger input with 50-kΩ typical internal pull-down resistor).
(2) DIN1/2/3/4 (Schmitt trigger input).
(3) SCKI, TEST/ADR1/RSV, MC/SCL/FMT, MD/SDA/DEMP, and AMUTEI (Schmitt trigger input, 5-V tolerant).
(4) RST and MS/ADR0/RSV (Schmitt trigger input with 50-kΩ typical internal pull-down resistor, 5-V tolerant).
(5) ZERO1 and ZERO2.
(6) SDA (I^2C mode, open-drain low output) and AMUTEO (open-drain low output).

ELECTRICAL CHARACTERISTICS: DAC

All specifications at T_A = +25°C, VCC1 = VCC2 = 5 V, VDD = 3.3 V, f_S = 48 kHz, SCKI = 512 f_S, 24-bit data, and Sampling Mode = Auto, unless otherwise noted.

PARAMETER		TEST CONDITIONS	PCM1690-Q1 MIN	PCM1690-Q1 TYP	PCM1690-Q1 MAX	UNIT
DAC CHARACTERISTICS						
Resolution			16	24		Bits
DC ACCURACY						
Gain mismatch channel-to-channel				±2.0	±6	% of FSR
Gain error				±2.0	±6	% of FSR
Bipolar zero error				±1.0		% of FSR
DYNAMIC PERFORMANCE(1) (2)						
Total harmonic distortion + noise	THD+N	f_S = 48 kHz, V_{OUT} = 0 dB		–94	–88	dB
		f_S = 96 kHz, V_{OUT} = 0 dB		–94		dB
		f_S = 192 kHz, V_{OUT} = 0 dB		–94		dB
Dynamic range		f_S = 48 kHz, EIAJ, A-weighted	106	113		dB
		f_S = 96 kHz, EIAJ, A-weighted		113		dB
		f_S = 192 kHz, EIAJ, A-weighted		113		dB
Sighnal-to-noise ratio	SNR	f_S = 48 kHz, EIAJ, A-weighted	106	113		dB
		f_S = 96 kHz, EIAJ, A-weighted		113		dB
		f_S = 192 kHz, EIAJ, A-weighted		113		dB
Channel separation (between one channel and others)		f_S = 48 kHz	103	109		dB
		f_S = 96 kHz		109		dB
		f_S = 192 kHz		108		dB
ANALOG OUTPUT						
Output voltage		Differential		1.6 × VCC1		V_{PP}
Center voltage				0.5 × VCC1		V
Load impedance		To ac-coupled GND(3)	5			kΩ
		To dc-coupled GND(3)	15			kΩ
LPF frequency response		f = 20 kHz		–0.04		dB
		f = 44 kHz		–0.18		dB
DIGITAL FILTER PERFORMANCE WITH SHARP ROLL-OFF						
Passband (single, dual)		Except SCKI = 128 f_S and 192 f_S			0.454 × f_S	Hz
		SCKI = 128 f_S and 192 f_S			0.432 × f_S	Hz
Passband (quad)					0.432 × f_S	Hz
Stop band (single, dual)		Except SCKI = 128 f_S and 192 f_S	0.546 × f_S			Hz
		SCKI = 128 f_S and 192 f_S	0.569 × f_S			Hz
Stop band (quad)			0.569 × f_S			Hz
Passband ripple		< 0.454 × f_S, 0.432 × f_S			±0.0018	dB
Stop band attenuation		> 0.546 × f_S, 0.569 × f_S	–75			dB

(1) In differential mode at VOUTx± pin, f_{OUT} = 1 kHz, using Audio Precision System II, Average mode with 20-kHz LPF and 400-Hz HPF.
(2) f_S = 48 kHz: SCKI = 512 f_S (single), f_S = 96 kHz : SCKI = 256 f_S (dual), f_S = 192 kHz : SCKI = 128 f_S (quad).
(3) Allowable minimum input resistance of differential to single-ended converter with D to S Gain = G is calculated as (1 + 2G)/(1 + G) × 5k for ac-coupled and (1+ 0.9G)/(1 + G) × 15k for dc-coupled connection; refer to Figure 41 and Figure 42 of the *Application Information* section.

ELECTRICAL CHARACTERISTICS: DAC (continued)

All specifications at T_A = +25°C, VCC1 = VCC2 = 5 V, VDD = 3.3 V, f_S = 48 kHz, SCKI = 512 f_S, 24-bit data, and Sampling Mode = Auto, unless otherwise noted.

PARAMETER	TEST CONDITIONS	PCM1690-Q1			UNIT
		MIN	TYP	MAX	
DIGITAL FILTER PERFORMANCE WITH SLOW ROLL-OFF					
Passband				0.328 × f_S	Hz
Stop band		0.673 × f_S			Hz
Passband ripple	< 0.328 × f_S			±0.0013	dB
Stop band attenuation	> 0.673 × f_S	–75			dB
DIGITAL FILTER PERFORMANCE					
Group delay time (single, dual)	Except SCKI = 128 f_S and 192 f_S		28/f_S		sec
	SCKI = 128 f_S and 192 f_S		19/f_S		sec
Group delay time (quad)			19/f_S		sec
De-emphasis error			±0.1		dB

ELECTRICAL CHARACTERISTICS: Power-Supply Requirements

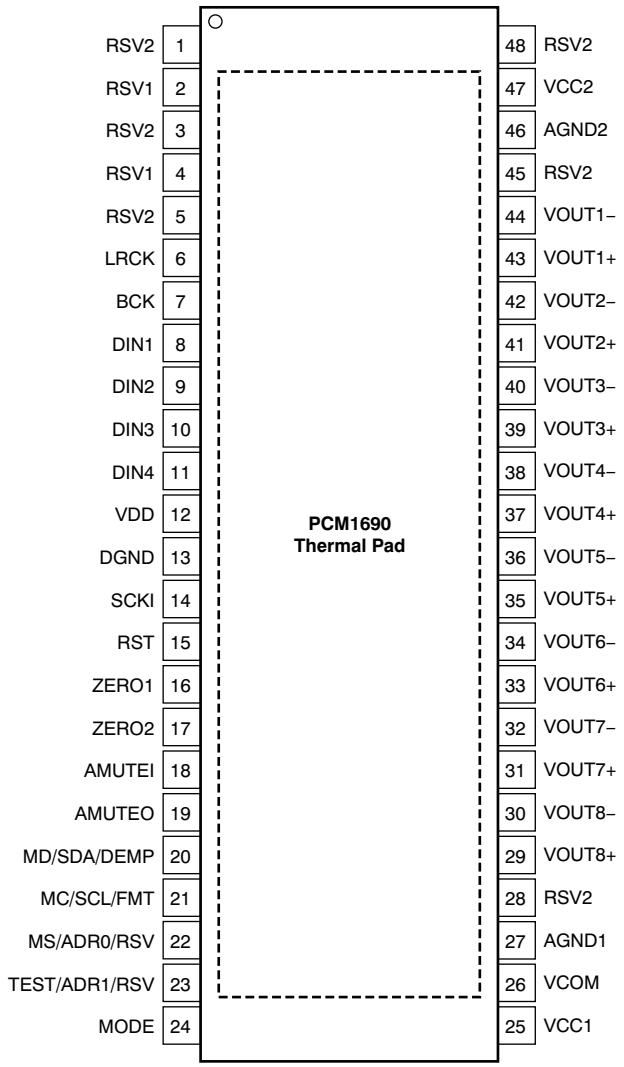
All specifications at T_A = +25°C, VCC1 = VCC2 = 5 V, VDD = 3.3 V, f_S = 48 kHz, SCKI = 512 f_S, 24-bit data, and Sampling Mode = Auto, unless otherwise noted.

PARAMETER		TEST CONDITIONS	PCM1690-Q1			UNIT
			MIN	TYP	MAX	
POWER-SUPPLY REQUIREMENTS						
Voltage range	VCC1/2		4.5	5.0	5.5	VDC
	VDD		3.0	3.3	3.6	VDC
Supply current	I_{CC}	f_S = 48 kHz		74	110	mA
		f_S = 192 kHz		74		mA
		Full power-down(1)		170		µA
	I_{DD}	f_S = 48 kHz		57	90	mA
		f_S = 192 kHz		76		mA
		Full power-down(1)		60		µA
Power dissipation		f_S = 48 kHz		558	847	mW
		f_S = 192 kHz		621		mW
		Full power-down(1)		1.05		mW
TEMPERATURE RANGE						
Operating temperature		PCM1690-Q1 Consumer grade	–40		+85	°C
Thermal resistance	θ_{JA}	HTSSOP-48		+23		°C/W

(1) SCKI, BCK, and LRCK stopped.

PIN CONFIGURATION

DCA PACKAGE
HTSSOP-48 (12 mm x 8 mm)
(TOP VIEW)



TERMINAL FUNCTIONS

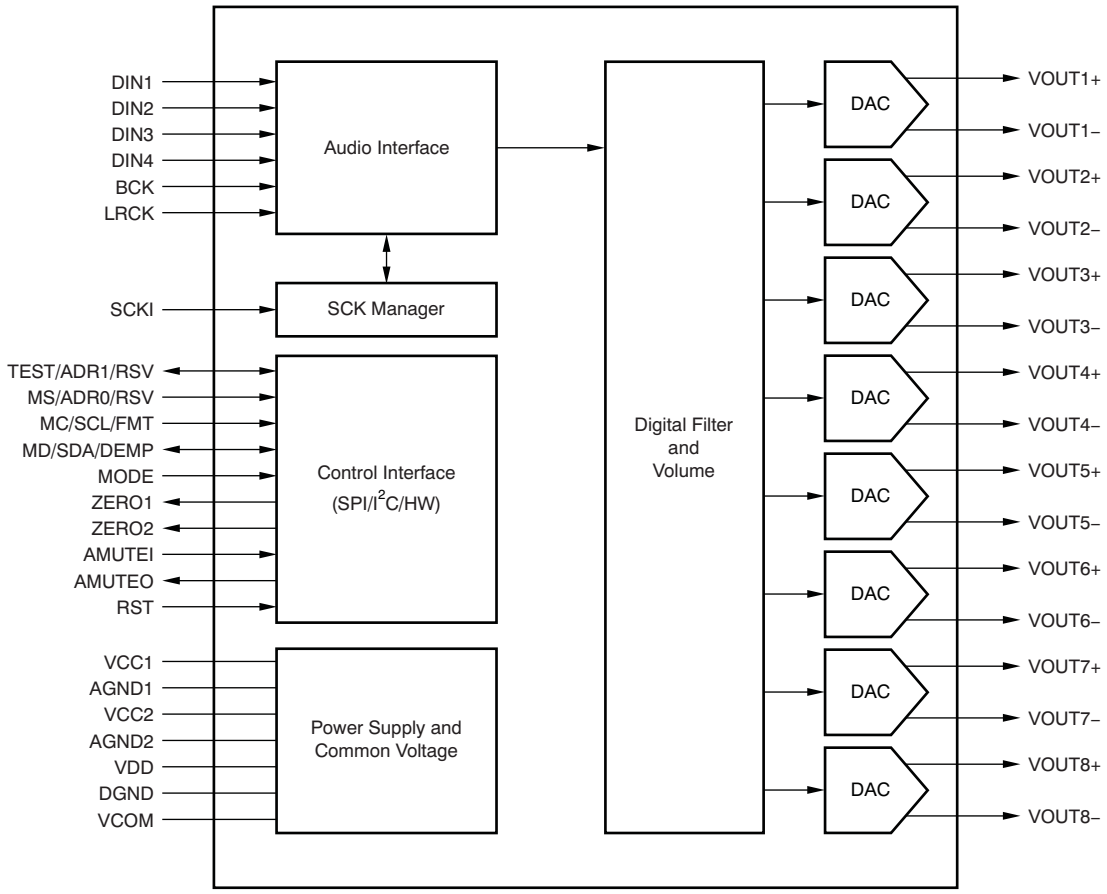
TERMINAL		I/O	PULL-DOWN	5-V TOLERANT	DESCRIPTION
NAME	PIN				
RSV2	1	—	—	—	Reserved, tied to analog ground
RSV1	2	—	—	—	Reserved, left open
RSV2	3	—	—	—	Reserved, tied to analog ground
RSV1	4	—	—	—	Reserved, left open
RSV2	5	—	—	—	Reserved, tied to analog ground
LRCK	6	I	Yes	No	Audio data word clock input
BCK	7	I	Yes	No	Audio data bit clock input
DIN1	8	I	No	No	Audio data input for DAC1 and DAC2
DIN2	9	I	No	No	Audio data input for DAC3 and DAC4
DIN3	10	I	No	No	Audio data input for DAC5 and DAC6
DIN4	11	I	No	No	Audio data input for DAC7 and DAC8

TERMINAL FUNCTIONS (continued)

TERMINAL		I/O	PULL-DOWN	5-V TOLERANT	DESCRIPTION
NAME	PIN				
VDD	12	—	—	—	Digital power supply, +3.3 V
DGND	13	—	—	—	Digital ground
SCKI	14	I	No	Yes	System clock input
RST	15	I	Yes	Yes	Reset and power-down control input with active low
ZERO1	16	O	No	No	Zero detect flag output 1
ZERO2	17	O	No	No	Zero detect flag output 2
AMUTEI	18	I	No	Yes	Analog mute control input with active low
AMUTEO	19	O	No	Yes	Analog mute status output(1) with active low
MD/SDA/DEMP	20	I/O	No	Yes	Input data for SPI, data for I^2C(1), de-emphasis control for hardware control mode
MC/SCL/FMT	21	I	No	Yes	Clock for SPI, clock for I^2C, format select for hardware control mode
MS/ADR0/RSV	22	I	Yes	Yes	Chip Select for SPI, address select 0 for I^2C, reserve (set low) for hardware control mode
TEST/ADR1/RSV	23	I/O	No	Yes	Test (factory use, left open) for SPI, address select 1 for I^2C, reserve (set low) for hardware control mode
MODE	24	I	No	No	Control port mode selection. Tied to VDD: SPI, left open: H/W mode, tied to DGND: I^2C
VCC1	25	—	—	—	Analog power supply 1, +5 V
VCOM	26	—	—	—	Voltage common decoupling
AGND1	27	—	—	—	Analog ground 1
RSV2	28	—	—	—	Reserved, tied to analog ground
VOUT8+	29	O	No	No	Positive analog output from DAC8
VOUT8-	30	O	No	No	Negative analog output from DAC8
VOUT7+	31	O	No	No	Positive analog output from DAC7
VOUT7-	32	O	No	No	Negative analog output from DAC7
VOUT6+	33	O	No	No	Positive analog output from DAC6
VOUT6-	34	O	No	No	Negative analog output from DAC6
VOUT5+	35	O	No	No	Positive analog output from DAC5
VOUT5-	36	O	No	No	Negative analog output from DAC5
VOUT4+	37	O	No	No	Positive analog output from DAC4
VOUT4-	38	O	No	No	Negative analog output from DAC4
VOUT3+	39	O	No	No	Positive analog output from DAC3
VOUT3-	40	O	No	No	Negative analog output from DAC3
VOUT2+	41	O	No	No	Positive analog output from DAC2
VOUT2-	42	O	No	No	Negative analog output from DAC2
VOUT1+	43	O	No	No	Positive analog output from DAC1
VOUT1-	44	O	No	No	Negative analog output from DAC1
RSV2	45	—	—	—	Reserved, tied to analog ground
AGND2	46	—	—	—	Analog ground 2
VCC2	47	—	—	—	Analog power supply 2, +5 V
RSV2	48	—	—	—	Reserved, tied to analog ground

(1) Open-drain configuration in out mode.

FUNCTIONAL BLOCK DIAGRAM



TYPICAL CHARACTERISTICS: Digital Filter

All specifications at T_A = +25°C, VCC1 = VCC2 = 5 V, VDD = 3.3 V, f_S = 48 kHz, SCKI = 512 f_S, 24-bit data, and Sampling Mode = Auto, unless otherwise noted.

FREQUENCY RESPONSE (Single Rate)

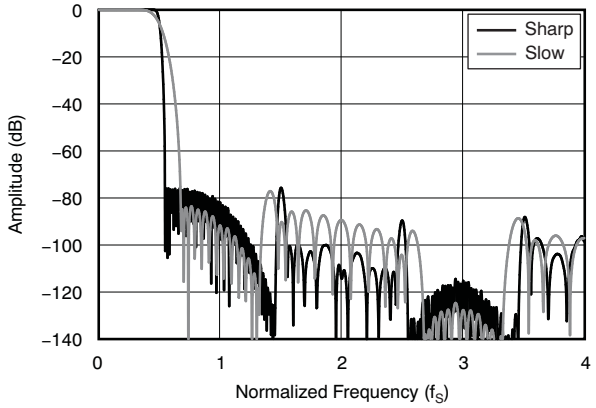


Figure 1.

FREQUENCY RESPONSE PASSBAND (Single Rate)

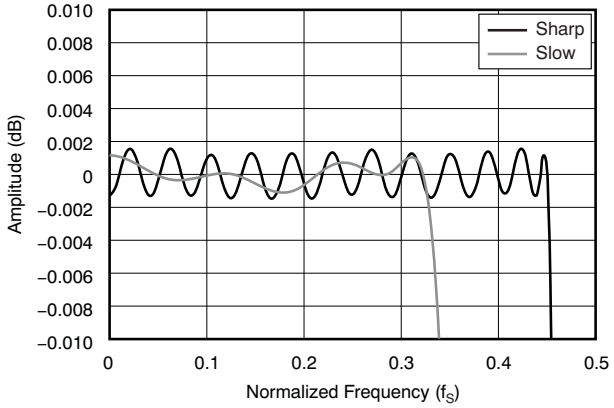


Figure 2.

FREQUENCY RESPONSE (Dual Rate)

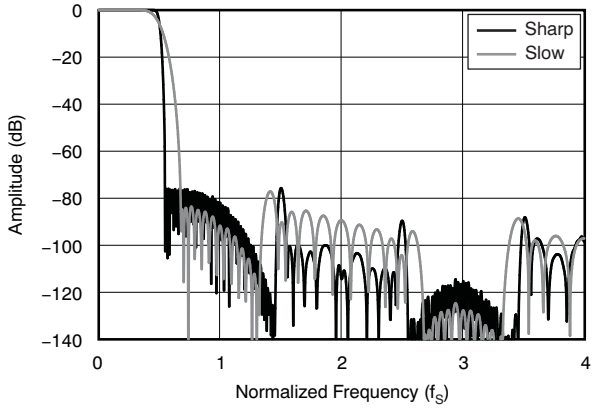


Figure 3.

FREQUENCY RESPONSE PASSBAND (Dual Rate)

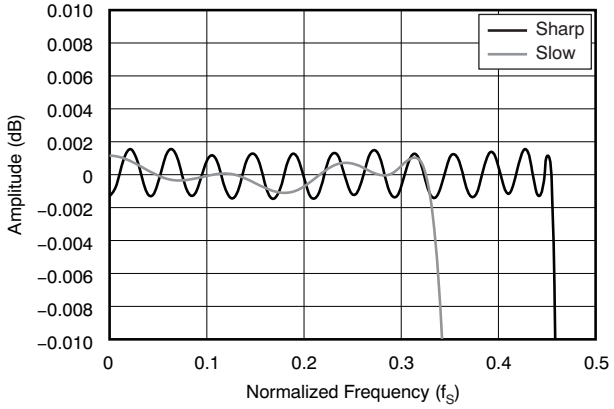


Figure 4.

FREQUENCY RESPONSE (Quad Rate)

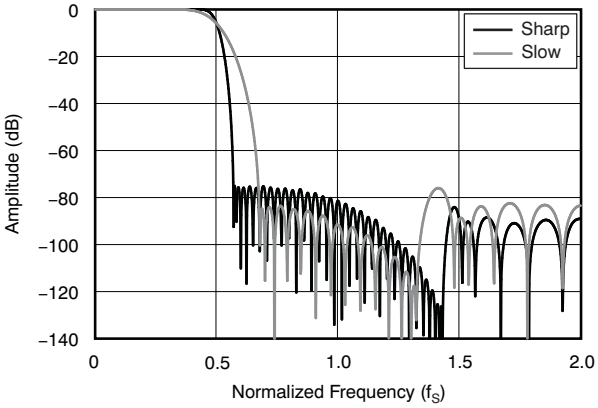


Figure 5.

FREQUENCY RESPONSE PASSBAND (Quad Rate)

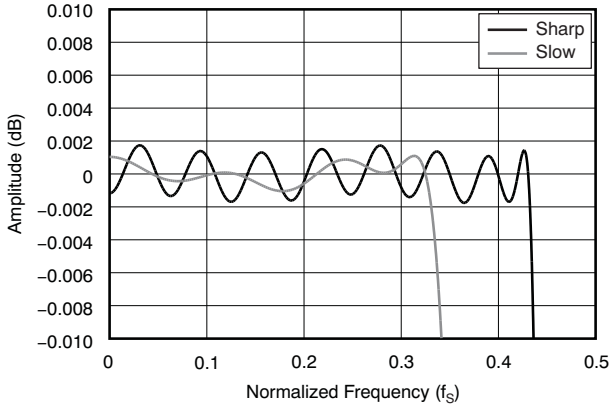


Figure 6.

TYPICAL CHARACTERISTICS: Digital De-Emphasis Filter

All specifications at T_A = +25°C, VCC1 = VCC2 = 5 V, VDD = 3.3 V, f_S = 48 kHz, SCKI = 512 f_S, 24-bit data, and Sampling Mode = Auto, unless otherwise noted.

DE-EMPHASIS CHARACTERISTIC (f_S = 48 kHz)

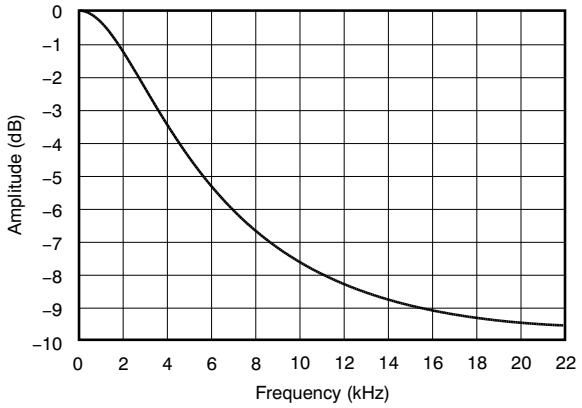


Figure 7.

DE-EMPHASIS CHARACTERISTIC (f_S = 44.1 kHz)

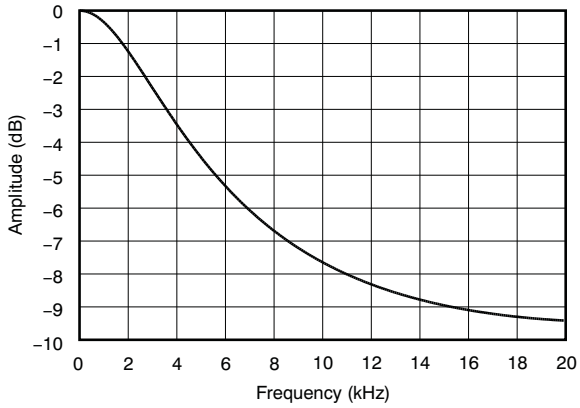


Figure 8.

DE-EMPHASIS CHARACTERISTIC (f_S = 32 kHz)

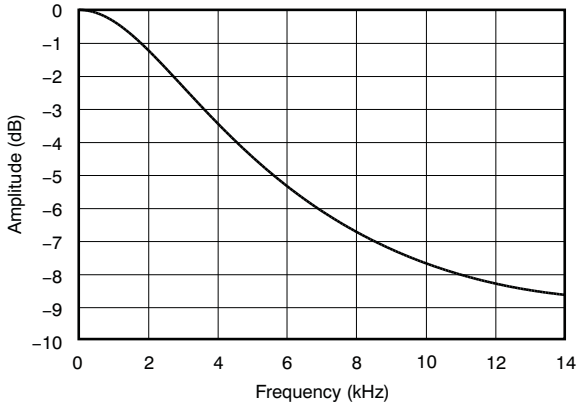


Figure 9.

ANALOG FILTER CHARACTERISTIC

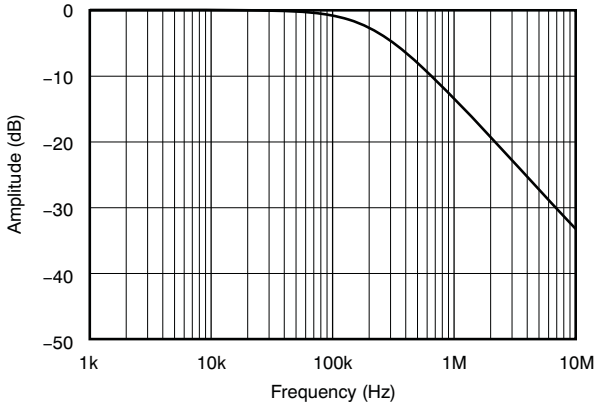


Figure 10.

TYPICAL CHARACTERISTICS: Dynamic Performance

All specifications at T_A = +25°C, VCC1 = VCC2 = 5 V, VDD = 3.3 V, f_S = 48 kHz, SCKI = 512 f_S, 24-bit data, and Sampling Mode = Auto, unless otherwise noted.

THD+N vs TEMPERATURE

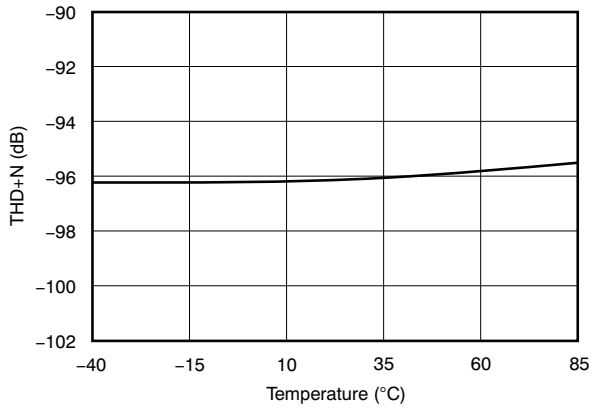


Figure 11.

DYNAMIC RANGE AND SNR vs TEMPERATURE

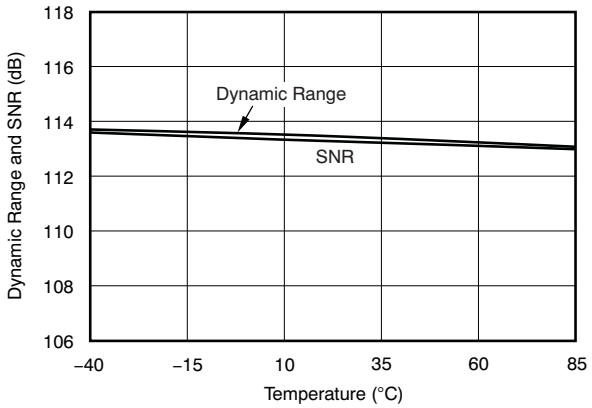


Figure 12.

THD+N vs SUPPLY VOLTAGE

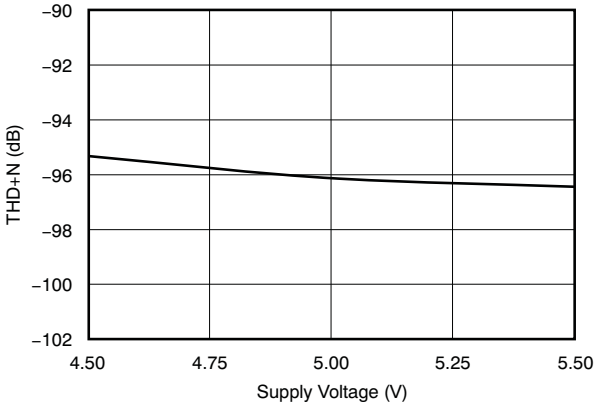


Figure 13.

DYNAMIC RANGE AND SNR vs SUPPLY VOLTAGE

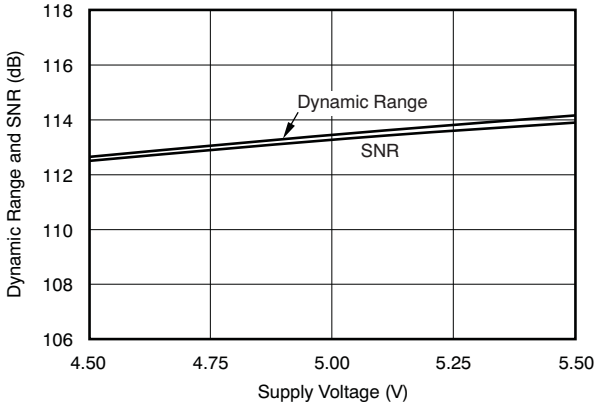


Figure 14.

TYPICAL CHARACTERISTICS: Output Spectrum

All specifications at T_A = +25°C, VCC1 = VCC2 = 5 V, VDD = 3.3 V, f_S = 48 kHz, SCKI = 512 f_S, 24-bit data, and Sampling Mode = Auto, unless otherwise noted.

OUTPUT SPECTRUM
(0 dB, N = 32768)

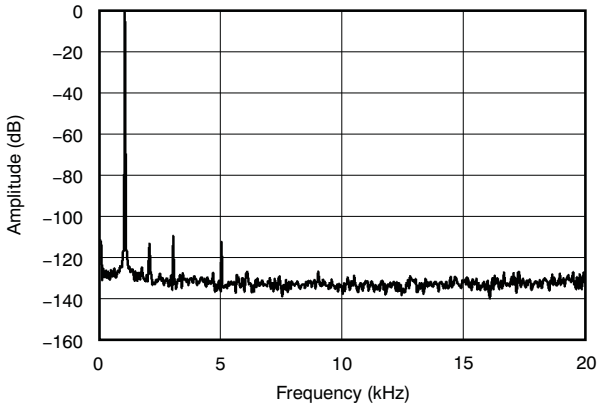


Figure 15.

OUTPUT SPECTRUM
(–60 dB, N = 32768)

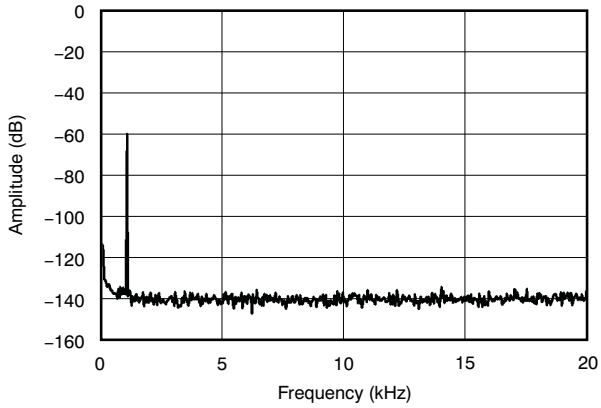


Figure 16.

OUTPUT SPECTRUM
(BPZ, N = 32768)

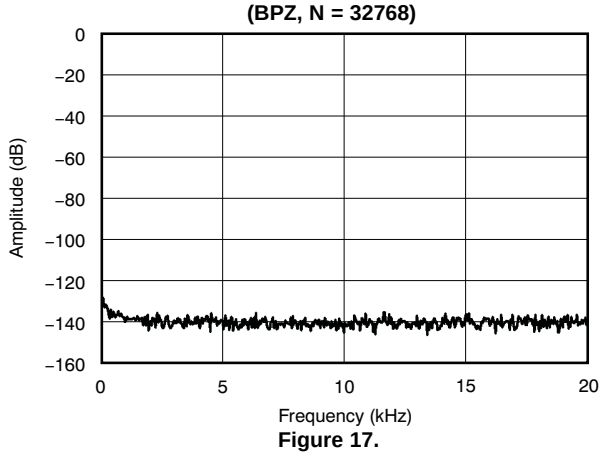


Figure 17.

PRODUCT OVERVIEW

The PCM1690-Q1 is a high-performance, multi-channel DAC targeted for consumer audio applications such as Blu-ray DVD players and HD DVD players, as well as home multi-channel audio applications (such as home theaters and A/V receivers). The PCM1690-Q1 consists of an eight-channel DAC. The DAC output type is fixed with a differential configuration. The PCM1690-Q1 supports 16-/20-/24-/32-bit linear PCM input data in I^2S- and left-justified audio formats, and 24-bit linear PCM input data in right-justified, DSP, and TDM formats for various sampling frequencies from 8 kHz to 192 kHz. The TDM format is useful for saving bus line interface numbers for multi-channel audio data communication between the DAC and a digital audio processor. The PCM1690-Q1 offers three modes for device control: two-wire I^2C software, three-wire SPI software, and hardware modes.

ANALOG OUTPUTS

The PCM1690-Q1 includes eight DACs, each with individual pairs of differential voltage outputs pins. The full-scale output voltage is (1.6 × VCC1) V_{PP} at the differential output mode. A dc-coupled load is allowed in addition to an ac-coupled load if the load resistance conforms to the specification. These balanced outputs are each capable of driving 0.8 VCC1 (4 V_{PP}) typical into a 5-kΩ, ac-coupled or 15-kΩ, dc-coupled load with VCC1 = +5 V. The internal output amplifiers for VOUT1 through VOUT8 are biased to the dc common voltage, equal to (0.5 × VCC1).

The output amplifiers include an RC continuous-time filter that helps to reduce the out-of-band noise energy present at the DAC outputs as a result of the noise shaping characteristics of the PCM1690-Q1 delta-sigma (ΔΣ) DACs. The frequency response of this filter is shown in the *Analog Filter Characteristic* (Figure 10) of the Typical Characteristics. By itself, this filter is not enough to attenuate the out-of-band noise to an acceptable level for most applications. An external low-pass filter is required to provide sufficient out-of-band noise rejection. Further discussion of DAC post-filter circuits is provided in the *Application Information* section.

Table 1. Pin Assignments in Differential Output Mode

DIGITAL INPUT	CHANNEL	DIFFERENTIAL OUTPUT
DIN1	1 (DAC1)	VOUT1+, VOUT1–
	2 (DAC2)	VOUT2+, VOUT2–
DIN2	3 (DAC3)	VOUT3+, VOUT3–
	4 (DAC4)	VOUT4+, VOUT4–
DIN3	5 (DAC5)	VOUT5+, VOUT5–
	6 (DAC6)	VOUT6+, VOUT6–
DIN4	7 (DAC7)	VOUT7+, VOUT7–
	8 (DAC8)	VOUT8+, VOUT8–

VOLTAGE REFERENCE VCOM

The PCM1690-Q1 includes a pin for the common-mode voltage output, VCOM. This pin should be connected to the analog ground via a decoupling capacitor. This pin can also be used to bias external high-impedance circuits, if they are required.

SYSTEM CLOCK INPUT

The PCM1690-Q1 requires an external system clock input applied at the SCKI input for DAC operation. The system clock operates at an integer multiple of the sampling frequency, or f_S. The multiples supported in DAC operation include 128 f_S, 192 f_S, 256 f_S, 384 f_S, 512 f_S, 768 f_S, and 1152 f_S. Details for these system clock multiples are shown in Table 2. Figure 18 and Table 3 show the SCKI timing requirements.

Table 2. System Clock Frequencies for Common Audio Sampling Rates

DEFAULT SAMPLING MODE	SAMPLING FREQUENCY	SYSTEM CLOCK FREQUENCY (MHz)						
	f_S (kHz)	128 f_S	192 f_S	256 f_S	384 f_S	512 f_S	768 f_S	1152 f_S
Single rate	8	N/A	N/A	2.0480	3.0720	4.0960	6.1440	9.2160
	16	2.0480	3.0720	4.0960	6.1440	8.1920	12.2880	18.4320
	32	4.0960	6.1440	8.1920	12.2880	16.3840	24.5760	36.8640
	44.1	5.6448	8.4672	11.2896	16.9344	22.5792	33.8688	N/A
	48	6.1440	9.2160	12.2880	18.4320	24.5760	36.8640	N/A
Dual rate	88.2	11.2896	16.9344	22.5792	33.8688	N/A	N/A	N/A
	96	12.2880	18.4320	24.5760	36.8640	N/A	N/A	N/A
Quad rate	176.4	22.5792	33.8688	N/A	N/A	N/A	N/A	N/A
	192	24.5760	36.8640	N/A	N/A	N/A	N/A	N/A

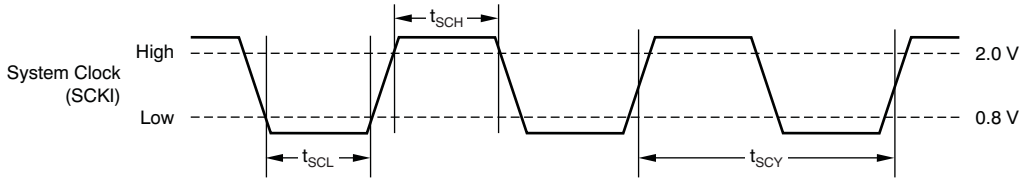


Figure 18. System Clock Timing Requirements

Table 3. Timing Requirements for Figure 18

SYMBOL	PARAMETER	MIN	MAX	UNIT
t_{SCY}	System clock cycle time	27		ns
t_{SCH}	System clock width high	10		ns
t_{SCL}	System clock width low	10		ns
—	System clock duty cycle	40	60	%

SAMPLING MODE

The PCM1690-Q1 supports three sampling modes (single rate, dual rate, and quad rate) in DAC operation. In single rate mode, the DAC operates at an oversampling frequency of x128 (except when SCKI = 128 f_S and 192 f_S). This mode is supported for sampling frequencies less than 50 kHz. In dual rate mode, the DAC operates at an oversampling frequency of x64; this mode is supported for sampling frequencies less than 100 kHz. In quad rate mode, the DAC operates at an oversampling frequency of x32. The sampling mode is automatically selected according to the ratio of system clock frequency and sampling frequency by default (that is, single rate for 512 f_S, 768 f_S, and 1152 f_S; dual rate for 256 f_S and 384 f_S; and quad rate for 128 f_S and 192 f_S), but manual selection is also possible for specified combinations through the serial mode control register.

Table 4 and Figure 19 show the relation among the oversampling rate (OSR) of the digital filter and ΔΣ modulator, the noise-free shaped bandwidth, and each sampling mode setting.

Table 4. DAC Filter OSR, Modulator OSR, and Noise-Free Shaped Bandwidth for Each Sampling Mode

SAMPLING MODE REGISTER SETTING	SYSTEM CLOCK FREQUENCY (xf_S)	NOISE-FREE SHAPED BANDWIDTH (kHz)(1)			DIGITAL FILTER OSR	MODULATOR OSR
		f_S = 48 kHz	f_S = 96 kHz	f_S = 192 kHz		
Auto	512, 768, 1152	40	N/A	N/A	×8	x128
	256, 384	20	40	N/A	x8	x64
	128, 192(2)	10	20	40	x4	x32
Single	512, 768, 1152	40	N/A	N/A	x8	x128
	256, 384	40	N/A	N/A	x8	x128
	128, 192(2)	20	N/A	N/A	x4	x64
Dual	256, 384	20	40	N/A	x8	x64
	128, 192(2)	20	40	N/A	x4	x64
Quad	128, 192(2)	10	20	40	x4	x32

(1) Bandwidth in which noise is shaped out.
(2) Quad mode filter characteristic is applied.

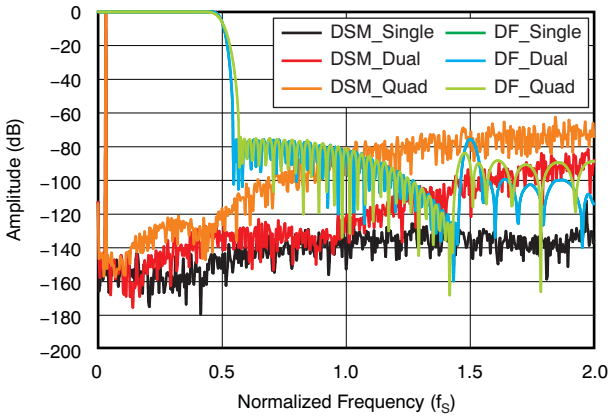


Figure 19. ΔΣ Modulator and Digital Filter Characteristic

RESET OPERATION

The PCM1690-Q1 has both an internal power-on reset circuit and an external reset circuit. The sequences for both reset circuits are illustrated in Figure 20 and Figure 21. Figure 20 describes the timing at the internal power-on reset. Initialization is triggered automatically at the point where VDD exceeds 2.2 V typical, and the internal reset is released after 3846 SCKI clock cycles from power-on if RST is held high and SCKI is provided. VOUT from the DACs are forced to the VCOM level initially (that is, 0.5 × VCC1) and settle at a specified level according to the rising VCC. If synchronization among SCKI, BCK, and LRCK is maintained, VOUT provides an output that corresponds to DIN after 3846 SCKI clocks from power-on. If the synchronization is not held, the internal reset is not released, and both operating modes are maintained at reset and power-down states; after synchronization forms again, the DAC returns to normal operation with the previous sequences.

Figure 21 illustrates a timing diagram at the external reset. RST accepts an externally-forced reset with RST low, and provides a device reset and power-down state that achieves the lowest power dissipation state available in the PCM1690-Q1. If RST goes from high to low under synchronization among SCKI, BCK, and LRCK, the internal reset is asserted, all registers and memory are reset, and finally the PCM1690-Q1 enters into all power-down states. At the same time, VOUT is immediately forced into the AGND1 level. To begin normal operation again, toggle RST high; the same power-up sequence is performed as the power-on reset shown in Figure 20.

The PCM1690-Q1 does not require particular power-on sequences for VCC and VDD; it allows VDD on and then VCC on, or VCC on and then VDD on. From the viewpoint of the Absolute Maximum Ratings, however, simultaneous power-on is recommended for avoiding unexpected responses on VOUTx. Figure 20 illustrates the response for VCC on with VDD on.

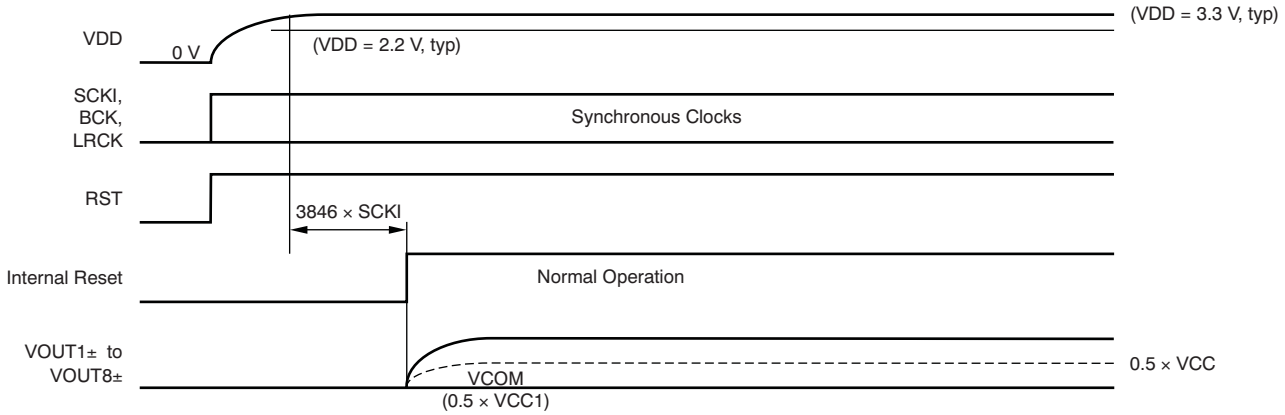


Figure 20. Power-On-Reset Timing Requirements

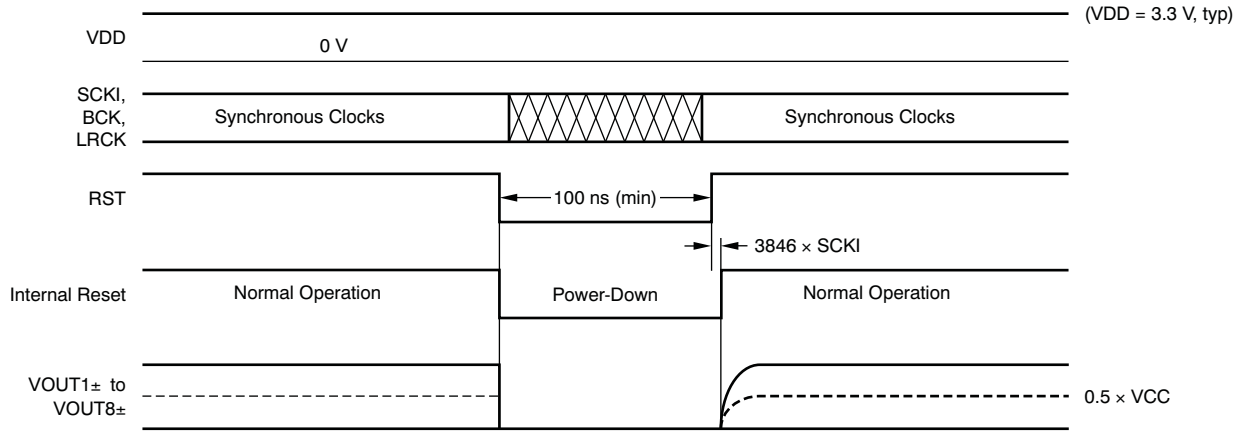


Figure 21. External Reset Timing Requirements

AUDIO SERIAL PORT OPERATION

The PCM1690-Q1 audio serial port consists of six signals: BCK, LRCK, DIN1, DIN2, DIN3, and DIN4. BCK is a bit clock input. LRCK is a left/right word clock input or frame synchronization clock input. DIN1/2/3/4 are the audio data inputs for VOUT1–8.

AUDIO DATA INTERFACE FORMATS AND TIMING

The PCM1690-Q1 supports 10 audio data interface formats: 16-/20-/24-/32-bit I^2S, 16-/20-/24-/32-bit left-justified, 24-bit right-justified, 16-bit right-justified, 24-bit left-justified mode DSP, 24-bit I^2S mode DSP, 24-bit left-justified mode TDM, 24-bit I^2S mode TDM, 24-bit left-justified mode high-speed TDM, and 24-bit I^2S mode high-speed TDM. In the case of I^2S, left-justified, and right-justified data formats, 64 BCKs, 48 BCKs, and 32 BCKs per LRCK period are supported; but 48 BCKs are limited in 192/384/768 f_S SCKI, and 32 BCKs are limited in 16-bit right-justified only. In the case of TDM data format in single rate, BCK, LRCK, and DIN1 are used. In the case of TDM data format in dual rate, BCK, LRCK, and DIN1/2 are used. In the case of high-speed TDM format in dual rate, BCK, LRCK, and DIN1 are used. In the case of high-speed TDM format in quad rate, BCK, LRCK, and DIN1/2 are used. TDM format and high-speed TDM format are supported only at SCKI = 512 f_S, 256 f_S, 128 f_S, and $f_{BCK} \le f_{SCKI}$. The audio data formats are selected by MC/SCL/FMT in hardware control mode and by control register settings in software control mode. All data must be in binary twos complement and MSB first.

Table 5 summarizes the applicable formats and describes the relationships among them and the respective restrictions with mode control. Figure 22 through Figure 28 show 10 audio interface data formats.

Table 5. Audio Data Interface Formats and Sampling Rate, Bit Clock, and System Clock Restrictions

CONTROL MODE	FORMAT	DATA BITS	MAX LRCK FREQUENCY (f_S)	SCKI RATE (xf_S)	BCK RATE (xf_S)	APPLICABLE PINS
Software control	I^2S/Left-Justified	16/20/24/32 (1)	192 kHz	128 to 1152 (2)	64, 48	DIN1/2/3/4
	Right-Justified	24, 16	192 kHz	128 to 1152 (2)	64, 48, 32 (16 bit) (3)	DIN1/2/3/4
	I^2S/Left-Justified DSP	24	192 kHz	128 to 768	64	DIN1/2/3/4
	I^2S/ Left-Justified TDM	24	48 kHz	256, 512	256	DIN1
		24	96 kHz	128, 256	128	DIN1/2
	High-Speed I^2S/Left-Justified TDM	24	96 kHz	256	256	DIN1
		24	192 kHz	128	128	DIN1/2
Hardware control	I^2S	16/20/24/32 (1)	192 kHz	128 to 1152 (2)	64, 48	DIN1/2/3/4
	I^2S TDM	24	48 kHz	512	256	DIN1
		24	96 kHz	256	128	DIN1/2

(1) 32-bit data length is acceptable only for BCK = 64 f_S and when using I^2S and Left-Justified format.
(2) 1152 f_S is acceptable only for f_S = 32 kHz, BCK = 64 f_S, and when using I^2S, Left-Justified, and 24-bit Right-Justified format.
(3) BCK = 32 f_S is supported only for 16-bit data length.

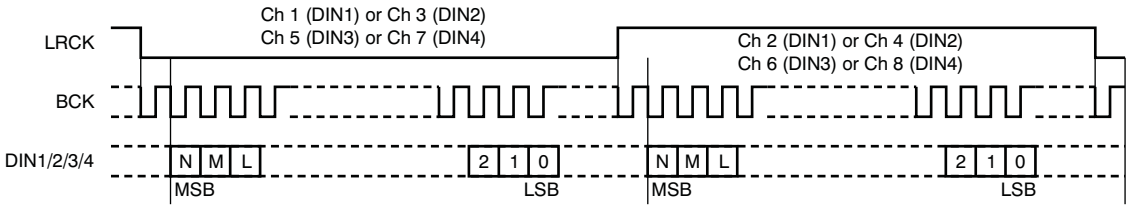


Figure 22. Audio Data Format: 16-/20-/24-/32-Bit I^2S (N = 15/19/23/31, M = 14/18/22/30, and L = 13/17/21/29)

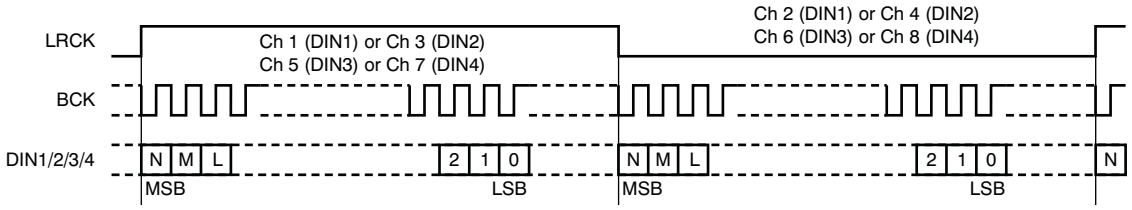


Figure 23. Audio Data Format: 16-/20-/24-/32-Bit Left-Justified (N = 15/19/23/31, M = 14/18/22/30, and L = 13/17/21/29)

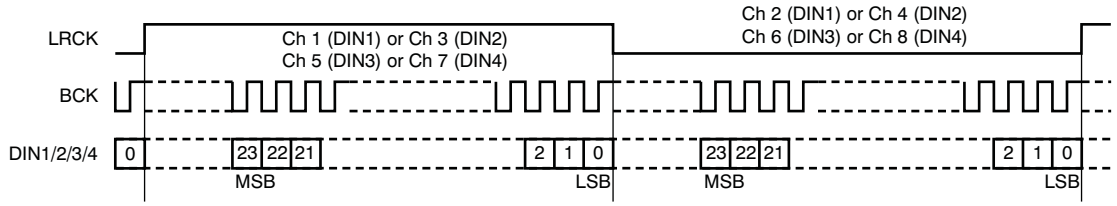


Figure 24. Audio Data Format: 24-Bit Right-Justified

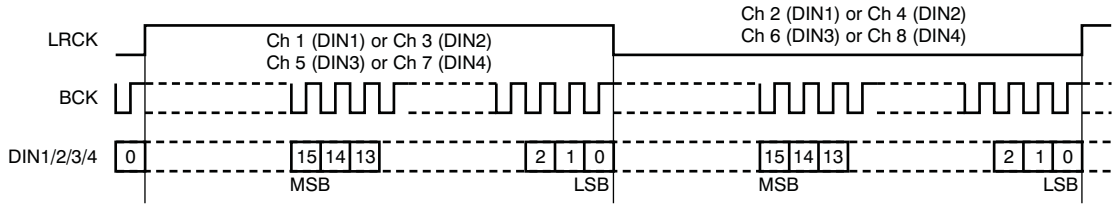


Figure 25. Audio Data Format: 16-Bit Right-Justified

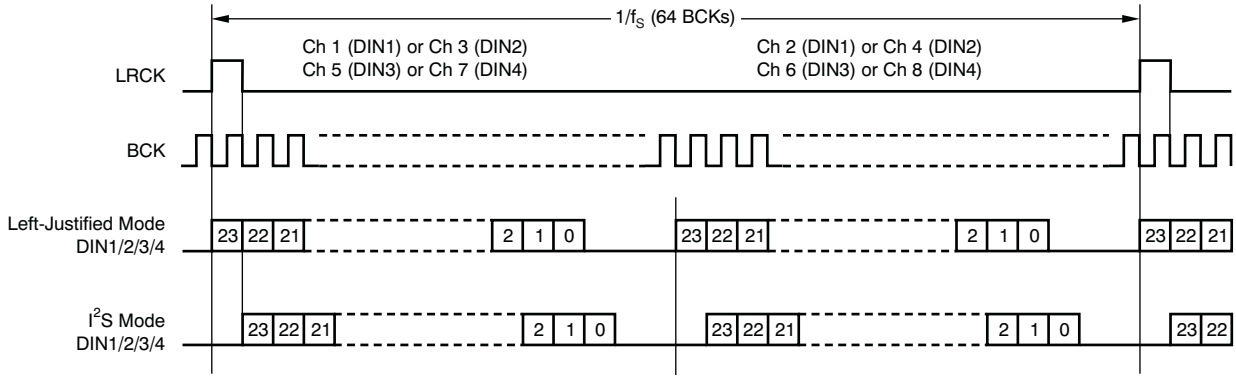


Figure 26. Audio Data Format: 24-Bit DSP Format

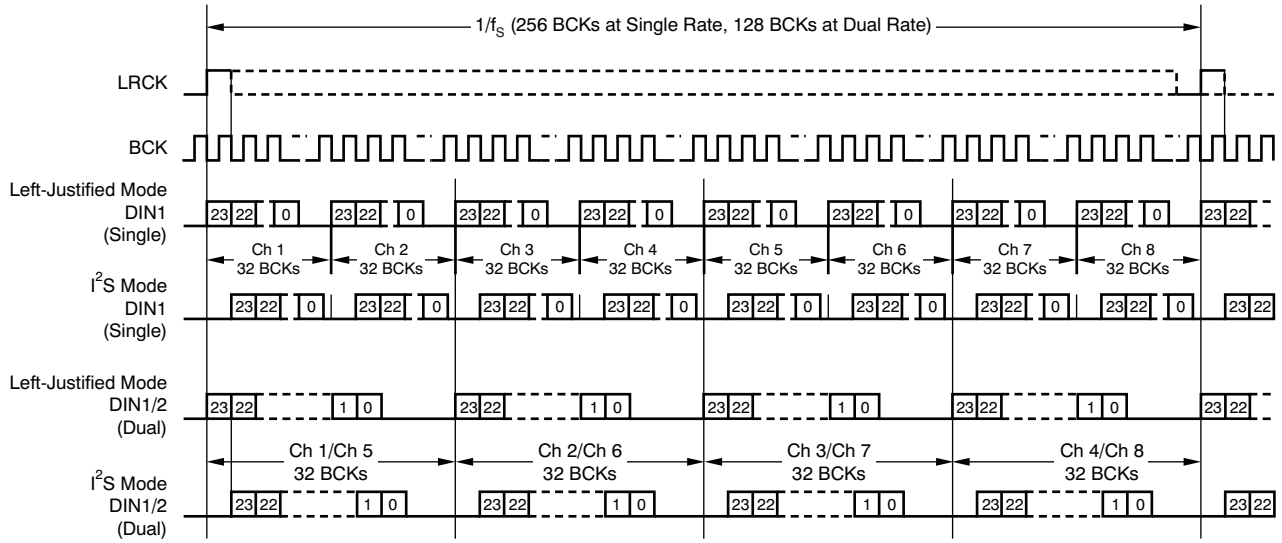


Figure 27. Audio Data Format: 24-Bit TDM Format (SCKI = 128 f_S, 256 f_S, and 512 f_S Only)

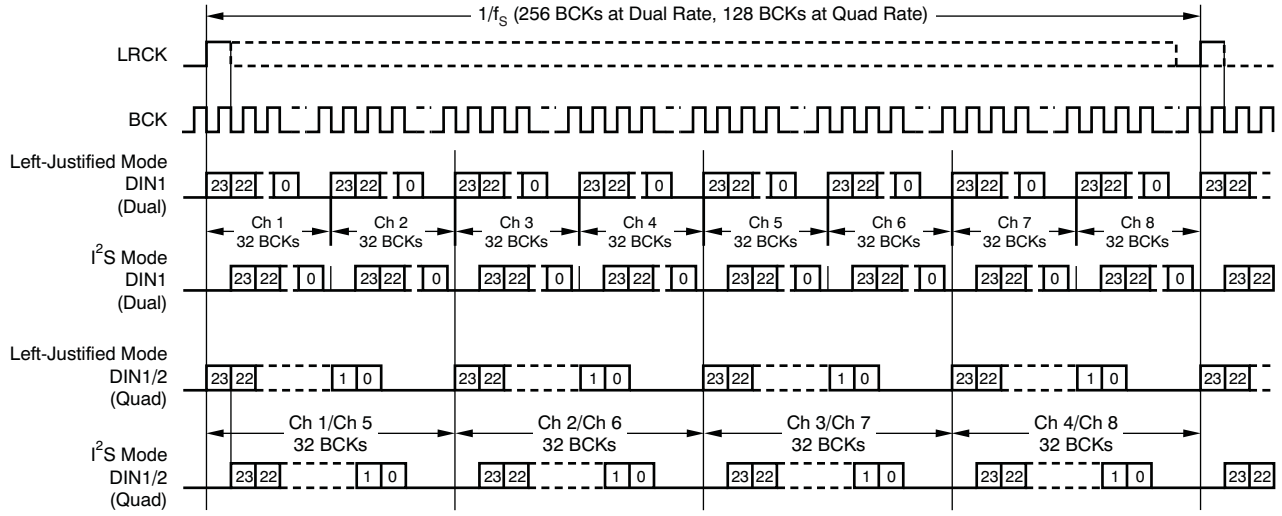


Figure 28. Audio Data Format: 24-Bit High-Speed TDM Format (SCKI = 128 f_S and 256 f_S Only)

AUDIO INTERFACE TIMING

Figure 29 and Figure 30 describe the detailed interface timing specifications.

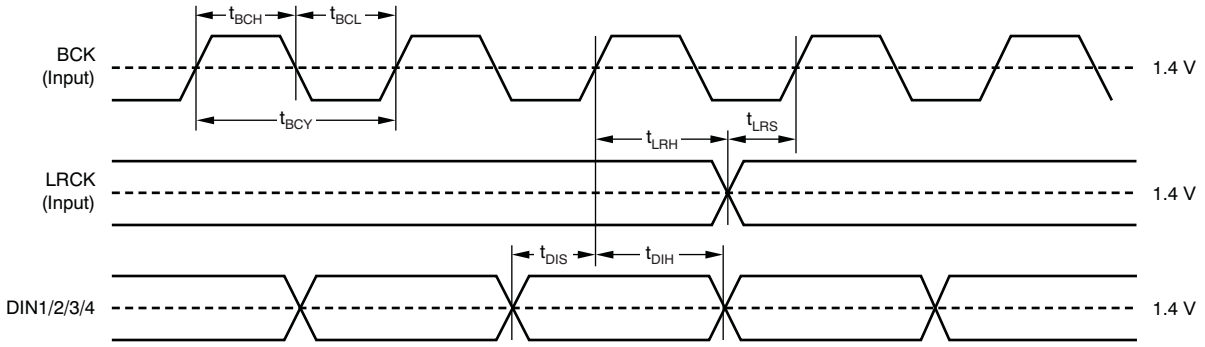


Figure 29. Audio Interface Timing Requirements for Left-Justified, Right-Justified, and I²S Data Formats

Table 6. Timing Requirements for Figure 29

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT
t_{BCY}	BCK cycle time	75			ns
t_{BCH}	BCK pulse width high	35			ns
t_{BCL}	BCK pulse width low	35			ns
t_{LRS}	LRCK setup time to BCK rising edge	10			ns
t_{LRH}	LRCK hold time to BCK rising edge	10			ns
t_{DIS}	DIN1/2/3/4 setup time to BCK rising edge	10			ns
t_{DIH}	DIN1/2/3/4 hold time to BCK rising edge	10			ns

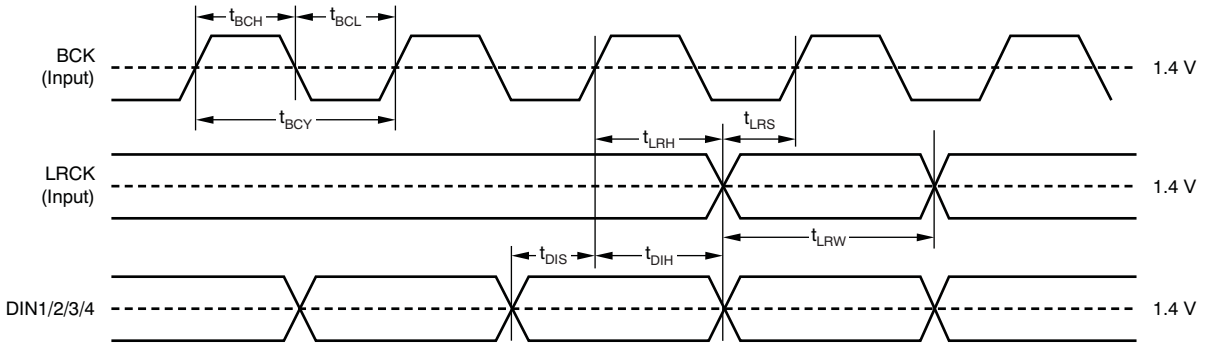


Figure 30. Audio Interface Timing Requirements for DSP and TDM Data Formats

Table 7. Timing Requirements for Figure 30

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT
t_{BCY}	BCK cycle time	40			ns
t_{BCH}	BCK pulse width high	15			ns
t_{BCL}	BCK pulse width low	15			ns
t_{LRW}	LRCK pulse width high (DSP format)	t_{BCY}		t_{BCY}	
	LRCK pulse width high (TDM format)	t_{BCY}		$1/f_S - t_{BCY}$	
t_{LRS}	LRCK setup time to BCK rising edge	10			ns
t_{LRH}	LRCK hold time to BCK rising edge	10			ns
t_{DIS}	DIN1/2/3/4 setup time to BCK rising edge	10			ns
t_{DIH}	DIN1/2/3/4 hold time to BCK rising edge	10			ns

SYNCHRONIZATION WITH THE DIGITAL AUDIO SYSTEM

The PCM1690-Q1 operates under the system clock (SCKI) and the audio sampling rate (LRCK). Therefore, SCKI and LRCK must have a specific relationship. The PCM1690-Q1 does not need a specific phase relationship between the audio interface clocks (LRCK, BCK) and the system clock (SCKI), but does require a specific frequency relationship (ratiometric) between LRCK, BCK, and SCKI.

If the relationship between SCKI and LRCK changes more than ±2 BCK clocks because of jitter, sampling frequency change, etc., the DAC internal operation stops within $1/f_S$, and the analog output is forced into VCOM (0.5 VCC1) until re-synchronization between SCKI, LRCK, and BCK completes and then $38/f_S$ (single, dual rate) or $29/f_S$ (quad rate) passes. In the event the change is less than ±2 BCKs, re-synchronization does not occur, and this analog output control and discontinuity does not occur.

Figure 31 shows the DAC analog output during loss of synchronization. During undefined data periods, some noise may be generated in the audio signal. Also, the transition of normal to undefined data and undefined (or zero) data to normal data creates a discontinuity of data on the analog outputs, which then may generate some noise in the audio signal.

DAC outputs (VOUTx) hold the previous state if the system clock halts, but the asynchronous and re-synchronization processes will occur after the system clock resumes.

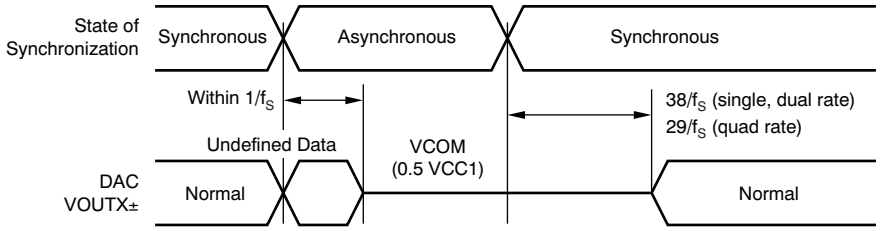


Figure 31. DAC Outputs During Loss of Synchronization

ZERO FLAG

The PCM1690-Q1 has two ZERO flag pins (ZERO1 and ZERO2) that can be assigned to the combinations shown in Table 8. Zero flag combinations are selected through control register settings. If the input data of the left and right channel of all assigned channels remain at '0' for 1024 sampling periods (LRCK clock periods), the ZERO1/2 bits are set to a high level, logic '1' state. Furthermore, if the input data of any channels of assigned channels read '1', the ZERO1/2 are set to a low level, logic '0' state, immediately. Zero data detection is supported for 16-/20-/24-bit data width, but is not supported for 32-bit data width.

The active polarity of the zero flag output can be inverted through control register settings. The reset default is active high for zero detection. In parallel hardware control mode, ZERO1 and ZERO2 are fixed with combination *A* shown in Table 8.

Table 8. Zero Flag Outputs Combination

ZERO FLAG COMBINATION	ZERO1	ZERO2
A	DATA1, left channel	DATA1, right channel
B	DATA1–4	DATA1–4
C	DATA4	DATA1–3
D	DATA1	DATA2–4

AMUTE CONTROL

The PCM1690-Q1 has an AMUTE control input, status output pins, and functionality. AMUTEI is the input control pin of the internal analog mute circuit. An AMUTEI low input causes the DAC output to cut-off from the digital input and forces it to the center level (0.5 VCC1). AMUTEO is the status output pin of the internal analog mute circuit. AMUTEO low indicates the analog mute control circuit is active because of a programmed condition (such as an SCKI halt, asynchronous detect, zero detect, or issue with the DAC disable command) that forces the DAC outputs to a center level. Because AMUTEI is not terminated internally and AMUTEO is an open-drain output, pull-ups by the appropriate resistors are required for proper operation.

Additionally, because the AMUTEI pin control and power-down control in register (OPEDA when high, PSMDA when low) do not function together, AMUTEI takes priority over power-down control. Therefore, power-down control is ignored during AMUTEI low, and AMUTEI low forces the DAC output to a center level (0.5 VCC1) even if the power-down control is asserted.

MODE CONTROL

The PCM1690-Q1 includes three mode control interfaces with two oversampling configurations, depending on the input state of the MODE pin, as shown in Table 9. The pull-up and pull-down resistors must each be less than 10 kΩ.

Table 9. Mode Control Selection

MODE	MODE CONTROL INTERFACE
Tied to DGND, low	Two-wire (I^2C) serial control, selectable oversampling configuration
Left open	Two-wire parallel control, auto mode oversampling configuration
Tied to VDD, high	Three-wire (SPI) serial control, selectable oversampling configuration

The input state of the MODE pin is sampled at the moment of power-on, or during a low-to-high transition of the RST pin, with the system clock input. Therefore, input changes after reset are ignored until the next power-on or reset. From the mode control selection described in Table 9, the functions of four pins are changed, as shown in Table 10.

Table 10. Pin Functions for Interface Mode

PIN	PIN ASSIGNMENTS		
	SPI	I^2C	H/W
20	MD (input)	SDA (input/output)	DEMP (input)
21	MC (input)	SCL (input)	FMT (input)
22	MS (input)	ADR0 (input)	RSV (input, low)
23	Test (output, open)	ADR1 (input)	RSV (input, low)

In serial mode control, the actual mode control is performed by register writes (and reads) through the SPI- or I^2C-compatible serial control port. In parallel mode control, two specific functions are controlled directly through the high/low control of two specific pins, as described in the following section.

PARALLEL HARDWARE CONTROL

The functions shown in Table 11 and Table 12 are controlled by two pins, DEMP and FMT, in parallel hardware control mode. The DEMP pin controls the 44.1-kHz digital de-emphasis function of all eight channels. The FMT pin controls the audio interface format for all eight channels.

Table 11. DEMP Functionality

DEMP	DESCRIPTION
Low	De-emphasis off
High	44.1 kHz de-emphasis on

Table 12. FMT Functionality

FMT	DESCRIPTION
Low	16-/20-/24-/32-bit I^2S format
High	24-bit I^2S mode TDM format

THREE-WIRE (SPI) SERIAL CONTROL

The PCM1690-Q1 includes an SPI-compatible serial port that operates asynchronously with the audio serial interface. The control interface consists of MD/SDA/DEMP, MC/SCL/FMT, and MS/ADR0/RSV. MD is the serial data input to program the mode control registers. MC is the serial bit clock that shifts the data into the control port. MS is the select input to enable the mode control port.

CONTROL DATA WORD FORMAT

All single write operations via the serial control port use 16-bit data words. Figure 32 shows the control data word format. The first bit (fixed at '0') is for write controls; after the first bit are seven other bits, labeled ADR[6:0] that set the register address for the write operation. The eight least significant bits (LSBs), D[7:0] on MD, contain the data to be written to the register specified by ADR[6:0].

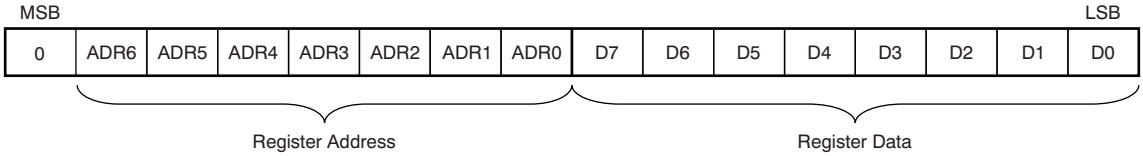
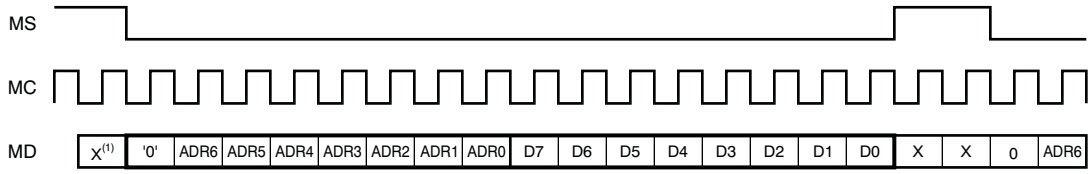


Figure 32. Control Data Word Format for MD

REGISTER WRITE OPERATION

Figure 33 shows the functional timing diagram for single write operations on the serial control port. MS is held at a high state until a register is to be written. To start the register write cycle, MS is set to a low state. 16 clocks are then provided on MC, corresponding to the 16 bits of the control data word on MD. After the 16th clock cycle has been completed, MS is set high to latch the data into the indexed mode control register.

Also, the PCM1690-Q1 supports multiple write operations in addition to single write operations, which can be performed by sending the following N-times of the 8-bit register data after the first 16-bit register address and register data while keeping the MC clocks and MS at a low state. Closing a multiple write operation can be accomplished by setting MS to a high state.



(1) X = don't care.

Figure 33. Register Write Operation

TIMING REQUIREMENTS

Figure 34 shows a detailed timing diagram for the three-wire serial control interface. These timing parameters are critical for proper control port operation.

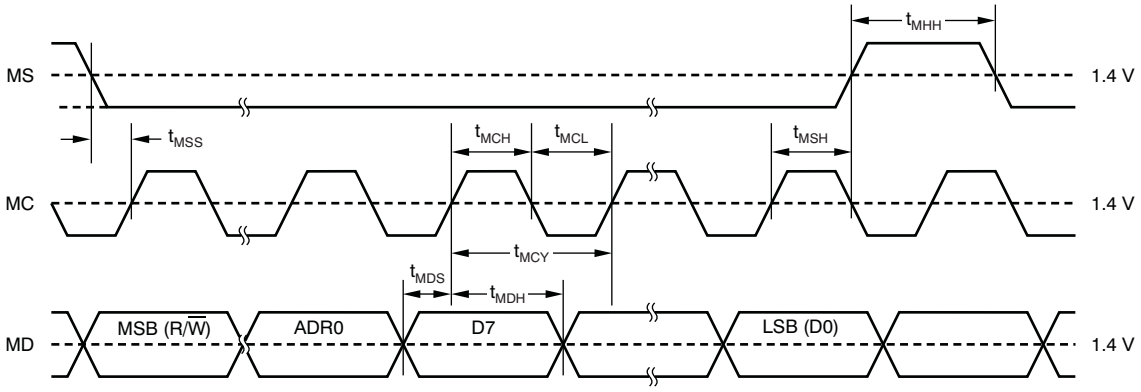


Figure 34. Three-Wire Serial Control Interface Timing

Table 13. Timing Requirements for Figure 34

SYMBOL	PARAMETER	MIN	MAX	UNIT
t_{MCY}	MC pulse cycle time	100		ns
t_{MCL}	MC low-level time	40		ns
t_{MCH}	MC high-level time	40		ns
t_{MHH}	MS high-level time	t_{MCY}		ns
t_{MSS}	MS falling edge to MC rising edge	30		ns
t_{MSH}	MS rising edge from MC rising edge for LSB	15		ns
t_{MDH}	MD hold time	15		ns
t_{MDS}	MD setup time	15		ns

TWO-WIRE (I^2C) SERIAL CONTROL

The PCM1690-Q1 supports an I^2C-compatible serial bus and data transmission protocol for fast mode configured as a slave device. This protocol is explained in the I^2C specification 2.0.

The PCM1690-Q1 has a 7-bit slave address, as shown in Figure 35. The first five bits are the most significant bits (MSB) of the slave address and are factory-preset to '10011'. The next two bits of the address byte are selectable bits that can be set by MS/ADR0/RSV and TEST/ADR1/RSV. A maximum of four PCM1690-Q1s can be connected on the same bus at any one time. Each PCM1690-Q1 responds when it receives its own slave address.

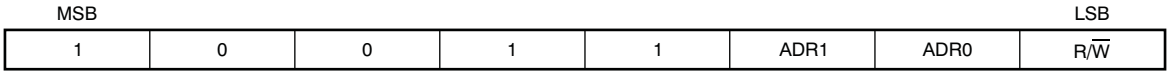
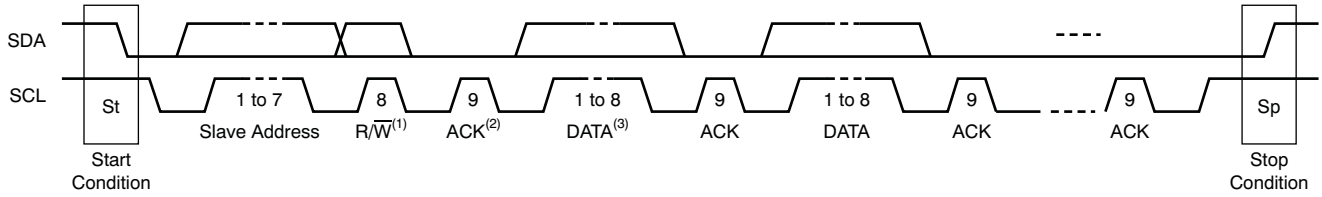


Figure 35. Slave Address

PACKET PROTOCOL

A master device must control the packet protocol, which consists of a start condition, slave address with the read/write bit, data if a write operation is required, acknowledgment if a read operation is required, and stop condition. The PCM1690-Q1 supports both slave receiver and transmitter functions. Details about DATA for both write and read operations are described in Figure 36.



(1) R/$\overline{W}$: Read operation if '1'; write operation otherwise.

(2) ACK: Acknowledgment of a byte if '0', not Acknowledgment of a byte if '1'.

(3) DATA: Eight bits (byte); details are described in the *Write Operation* and *Read Operation* sections.

Figure 36. I²C Packet Control Protocol

WRITE OPERATION

The PCM1690-Q1 supports a receiver function. A master device can write to any PCM1690-Q1 register using single or multiple accesses. The master sends a PCM1690-Q1 slave address with a write bit, a register address, and the data. If multiple access is required, the address is that of the starting register, followed by the data to be transferred. When valid data are received, the index register automatically increments by one. When the register address reaches &h4F, the next value is &h40. When undefined registers are accessed, the PCM1690-Q1 does not send an acknowledgment. Figure 37 illustrates a diagram of the write operation. The register address and write data are in 8-bit, MSB-first format.

Transmitter	M	M	M	S	M	S	M	S	M	S		S	M
Data Type	St	Slave Address	$\overline{W}$	ACK	Reg Address	ACK	Write Data 1	ACK	Write Data 2	ACK		ACK	Sp

NOTE: M = Master device, S = Slave device, St = Start condition, $\overline{W}$ = Write, ACK = Acknowledge, and Sp = Stop condition.

Figure 37. Framework for Write Operation

READ OPERATION

A master device can read the registers of the PCM1690-Q1. The value of the register address is stored in an indirect index register in advance. The master sends the PCM1690-Q1 slave address with a read bit after storing the register address. Then the PCM1690-Q1 transfers the data that the index register points to. Figure 38 shows a diagram of the read operation.

Transmitter	M	M	M	S	M	S	M	M	M	S	S	M	M
Data Type	St	Slave Address	$\overline{W}$	ACK	Reg Address	ACK	Sr	Slave Address	R	ACK	Read Data	NACK	Sp

NOTE: M = Master device, S = Slave device, St = Start condition, Sr = Repeated start condition, $\overline{W}$ = Write, R = Read, ACK = Acknowledge, NACK = Not acknowledge, and Sp = Stop condition.

NOTE: The slave address after the repeated start condition must be the same as the previous slave address.

Figure 38. Framework for Read Operation

TIMING REQUIREMENTS: SCL AND SDA

A detailed timing diagram for SCL and SDA is shown in Figure 39.

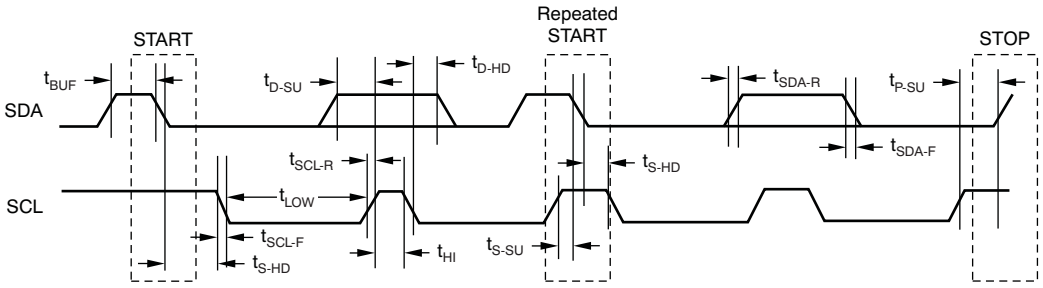


Figure 39. SCL and SDA Control Interface Timing

Table 14. Timing Requirements for Figure 39

SYMBOL	PARAMETER	STANDARD MODE		FAST MODE		UNIT
		MIN	MAX	MIN	MAX	
f_{SCL}	SCL clock frequency		100		400	kHz
t_{BUF}	Bus free time between STOP and START condition	4.7		1.3		µs
t_{LOW}	Low period of the SCL clock	4.7		1.3		µs
t_{HI}	High period of the SCL clock	4.0		0.6		µs
t_{S-SU}	Setup time for START/Repeated START condition	4.7		0.6		µs
t_{S-HD}	Hold time for START/Repeated START condition	4.0		0.6		µs
t_{D-SU}	Data setup time	250		100		ns
t_{D-HD}	Data hold time	0	3450	0	900	ns
t_{SCL-R}	Rise time of SCL signal		1000	20 + 0.1 C_B	300	ns
t_{SCL-F}	Fall time of SCL signal		1000	20 + 0.1 C_B	300	ns
t_{SDA-R}	Rise time of SDA signal		1000	20 + 0.1 C_B	300	ns
t_{SDA-F}	Fall time of SDA signal		1000	20 + 0.1 C_B	300	ns
t_{P-SU}	Setup time for STOP condition	4.0		0.6		µs
t_{GW}	Allowable glitch width		N/A		50	
C_B	Capacitive load for SDA and SCL line		400		100	pF
V_{NH}	Noise margin at high level for each connected device (including hysteresis)	0.2 × VDD		0.2 × VDD		V
V_{NL}	Noise margin at low level for each connected device (including hysteresis)	0.1 × VDD		0.1 × VDD		V
V_{HYS}	Hysteresis of Schmitt trigger input	N/A		0.05 × VDD		V

CONTROL REGISTER DEFINITIONS (SOFTWARE MODE ONLY)

The PCM1690-Q1 has many user-programmable functions that are accessed via control registers, and are programmed through the SPI or I^2C serial control port. Table 15 shows the available mode control functions along with reset default conditions and associated register address. Table 16 lists the register map.

Table 15. User-Programmable Mode Control Functions

FUNCTION	RESET DEFAULT	REGISTER	LABEL
Mode control register reset	Normal operation	64	MRST
System reset	Normal operation	64	SRST
Analog mute function control	Mute disabled	64	AMUTE[3:0]
Sampling mode selection	Auto	64	SRDA[1:0]
Power-save mode selection	Power save	65	PSMDA
Audio interface format selection	I^2S	65	FMTDA[3:0]
Operation control	Normal operation	66	OPEDA[3:0]
Digital filter roll-off control	Sharp roll-off	66	FLT[3:0]
Output phase selection	Normal	67	REVDA[8:1]
Soft mute control	Mute disabled	68	MUTDA[8:1]
Zero flag	Not detected	69	ZERO[8:1]
Digital attenuation mode	0 dB to –63 dB, 0.5 dB step	70	DAMS
Digital de-emphasis function control	Disabled	70	DEMP[1:0]
Zero flag function selection	ZERO1: DIN1, left-channel ZERO2: DIN1, right-channel	70	AZRO[1:0]
Zero flag polarity selection	High for detection	70	ZREV
Digital attenuation level setting	0 dB, no attenuation	71–79	ATDAx[7:0]

Table 16. Register Map

ADR[6:0]		DATA[7:0]							
DEC	HEX	B7	B6	B5	B4	B3	B2	B1	B0
64	40	MRST	SRST	AMUTE3	AMUTE2	AMUTE1	AMUTE0	SRDA1	SRDA0
65	41	PSMDA	RSV(1)	RSV(1)	RSV(1)	FMTDA3	FMTDA2	FMTDA1	FMTDA0
66	42	OPEDA3	OPEDA2	OPEDA1	OPEDA0	FLT3	FLT2	FLT1	FLT0
67	43	REVDA8	REVDA7	REVDA6	REVDA5	REVDA4	REVDA3	REVDA2	REVDA1
68	44	MUTDA8	MUTDA7	MUTDA6	MUTDA5	MUTDA4	MUTDA3	MUTDA2	MUTDA1
69	45	ZERO8	ZERO7	ZERO6	ZERO5	ZERO4	ZERO3	ZERO2	ZERO1
70	46	DAMS	RSV(1)	DEMP1	DEMP0	RSV(1)	AZRO1	AZRO0	ZREV
71	47	RSV(1)	RSV(1)	RSV(1)	RSV(1)	RSV(1)	RSV(1)	RSV(1)	RSV(1)
72	48	ATDA17	ATDA16	ATDA15	ATDA14	ATDA13	ATDA12	ATDA11	ATDA10
73	49	ATDA27	ATDA26	ATDA25	ATDA24	ATDA23	ATDA22	ATDA21	ATDA20
74	4A	ATDA37	ATDA36	ATDA35	ATDA34	ATDA33	ATDA32	ATDA31	ATDA30
75	4B	ATDA47	ATDA46	ATDA45	ATDA44	ATDA43	ATDA42	ATDA41	ATDA40
76	4C	ATDA57	ATDA56	ATDA55	ATDA54	ATDA53	ATDA52	ATDA51	ATDA50
77	4D	ATDA67	ATDA66	ATDA65	ATDA64	ATDA63	ATDA62	ATDA61	ATDA60
78	4E	ATDA77	ATDA76	ATDA75	ATDA74	ATDA73	ATDA72	ATDA71	ATDA70
79	4F	ATDA87	ATDA86	ATDA85	ATDA84	ATDA83	ATDA82	ATDA81	ATDA80

(1) RSV must be set to '0'.

REGISTER DEFINITIONS

DEC	HEX	B7	B6	B5	B4	B3	B2	B1	B0
64	40	MRST	SRST	AMUTE3	AMUTE2	AMUTE1	AMUTE0	SRDA1	SRDA0

MRST **Mode control register reset**

This bit sets the mode control register reset to the default value. Pop noise may be generated. Returning the MRST bit to '1' is unnecessary, because it is automatically set to '1' after the mode control register is reset.

Default value = 1.

MRST	Mode control register reset
0	Set default value
1	Normal operation (default)

SRST **System reset**

This bit controls system reset, the resynchronization between the system clock and sampling clock, and DAC operation restart. The mode control register is not reset and the PCM1690-Q1 does not go into a power-down state. Returning the SRST bit to '1' is unnecessary; it is automatically set to '1' after triggering a system reset.

Default value = 1.

SRST	System reset
0	Resynchronization
1	Normal operation (default)

AMUTE[3:0] **Analog mute function control**

These bits control the enabling/disabling of each source event that triggers the analog mute control circuit.

Default value = 0000.

AMUTE	Analog mute function control
xxx0	Disable analog mute control by SCKI lost
xxx1	Enable analog mute control by SCKI lost
xx0x	Disable analog mute control by asynchronous detect
xx1x	Enable analog mute control by asynchronous detect
x0xx	Disable analog mute control by ZERO1 and ZERO2 detect
x1xx	Enable analog mute control by ZERO1 and ZERO2 detect
0xxx	Disable analog mute control by DAC disable command
1xxx	Enable analog mute control by DAC disable command

SRDA[1:0] Sampling mode selection

These bits control the sampling mode of DAC operation. In Auto mode, the sampling mode is automatically set according to multiples between the system clock and sampling clock, single rate for 512 f_S, 768 f_S, and 1152 f_S, dual rate for 256 f_S or 384 f_S, and quad rate for 128 f_S and 192 f_S.

Default value = 00.

SRDA	Sampling mode selection
00	Auto (default)
01	Single rate
10	Dual rate
11	Quad rate

DEC	HEX	B7	B6	B5	B4	B3	B2	B1	B0
65	41	PSMDA	RSV	RSV	RSV	FMTDA3	FMTDA2	FMTDA1	FMTDA0

PSMDA Power-save mode selection

This bit selects the power-save mode for the OPEDA[3:0] function. When PSMDA = 0, OPEDA[3:0] controls the power-save mode and normal operation. When PSMDA = 1, OPEDA functions controls the DAC disable (not power-save mode) and normal operation.

Default value: 0.

PSMDA	Power-save mode selection
0	Power-save enable mode (default)
1	Power-save disable mode

RSV Reserved

Reserved; do not use.

FMTDA[3:0] Audio interface format selection

These bits control the audio interface format for DAC operation. Details of the format, and any related restrictions with the system clock are described in the *Audio Data Interface Formats and Timing* section.

Default value: 0000 (16-/20-/24-/32-bit I^2S format).

FMTDA	Audio interface format selection
0000	16-/20-/24-/32-bit I^2S format (default)
0001	16-/20-/24-/32-bit left-justified format
0010	24-bit right-justified format
0011	16-bit right-justified format
0100	24-bit I^2S mode DSP format
0101	24-bit left-justified mode DSP format
0110	24-bit I^2S mode TDM format
0111	24-bit left-justified mode TDM format
1000	24-bit high-speed I^2S mode TDM format
1001	24-bit high-speed left-justified mode TDM format
101x	Reserved
11xx	Reserved

DEC	HEX	B7	B6	B5	B4	B3	B2	B1	B0
66	42	OPEDA3	OPEDA2	OPEDA1	OPEDA0	FLT3	FLT2	FLT1	FLT0

OPEDA[3:0] Operation control

These bits control the DAC operation mode. In operation disable mode, the DAC output is cut off from DIN and the internal DAC data are reset. If PSMDA = 1, the DAC output is forced into VCOM. IF PSMDA = 0, the DAC output is forced into AGND and the DAC goes into a power-down state. For normal operating mode, these bits must be '0'. The serial mode control is effective during operation disable mode.

Default value: 0000.

OPEDA	Operation control
xxx0	DAC1/2 normal operation
xxx1	DAC1/2 operation disable with or without power save
xx0x	DAC3/4 normal operation
xx1x	DAC3/4 operation disable with or without power save
x0xx	DAC5/6 normal operation
x1xx	DAC5/6 operation disable with or without power save
0xxx	DAC7/8 normal operation
1xxx	DAC7/8 operation disable with or without power save

FLT[3:0] Digital filter roll-off control

These bits allow users to select the digital filter roll-off that is best suited to their applications. Sharp and slow filter roll-off selections are available. The filter responses for these selections are shown in the Typical Characteristics section of this data sheet.

Default value: 0000.

FLT	Digital filter roll-off control
xxx0	DAC1/2 sharp roll-off
xxx1	DAC1/2 slow roll-off
xx0x	DAC3/4 sharp roll-off
xx1x	DAC3/4 slow roll-off
x0xx	DAC5/6 sharp roll-off
x1xx	DAC5/6 slow roll-off
0xxx	DAC7/8 sharp roll-off
1xxx	DAC7/8 slow roll-off

DEC	HEX	B7	B6	B5	B4	B3	B2	B1	B0
67	43	REVDA8	REVDA7	REVDA6	REVDA5	REVDA4	REVDA3	REVDA2	REVDA1

REVDA[8:1] Output phase selection

These bits are used to control the phase of DAC analog signal outputs.

Default value: 0000 0000.

REVDA	Output phase selection
xxxx xxx0	DAC1 normal output
xxxx xxx1	DAC1 inverted output
xxxx xx0x	DAC2 normal output
xxxx xx1x	DAC2 inverted output
xxxx x0xx	DAC3 normal output
xxxx x1xx	DAC3 inverted output
xxxx 0xxx	DAC4 normal output
xxxx 1xxx	DAC4 inverted output
xxx0 xxxx	DAC5 normal output
xxx1 xxxx	DAC5 inverted output
xx0x xxxx	DAC6 normal output
xx1x xxxx	DAC6 inverted output
x0xx xxxx	DAC7 normal output
x1xx xxxx	DAC7 inverted output
0xxx xxxx	DAC8 normal output
1xxx xxxx	DAC8 inverted output

DEC	HEX	B7	B6	B5	B4	B3	B2	B1	B0
68	44	MUTDA8	MUTDA7	MUTDA6	MUTDA5	MUTDA4	MUTDA3	MUTDA2	MUTDA1

MUTDA[8:1] Soft Mute control

These bits are used to enable or disable the Soft Mute function for the corresponding DAC outputs, VOUT. The Soft Mute function is incorporated into the digital attenuators. When mute is disabled (MUTDA[8:1] = 0), the attenuator and DAC operate normally. When mute is enabled by setting MUTDA[8:1] = 1, the digital attenuator for the corresponding output is decreased from the current setting to infinite attenuation. By setting MUTDA[8:1] = 0, the attenuator is increased to the last attenuation level in the same manner as it is for decreasing levels. This configuration reduces *pop and zipper noise* during muting of the DAC output. This Soft Mute control uses the same resource of digital attenuation level setting. Mute control has priority over the digital attenuation level setting.

Default value: 0000 0000.

MUTDA	Soft Mute control
xxxx xxx0	DAC1 Mute disabled
xxxx xxx1	DAC1 Mute enabled
xxxx xx0x	DAC2 Mute disabled
xxxx xx1x	DAC2 Mute enabled
xxxx x0xx	DAC3 Mute disabled
xxxx x1xx	DAC3 Mute enabled
xxxx 0xxx	DAC4 Mute disabled
xxxx 1xxx	DAC4 Mute enabled
xxx0 xxxx	DAC5 Mute disabled
xxx1 xxxx	DAC5 Mute enabled
xx0x xxxx	DAC6 Mute disabled
xx1x xxxx	DAC6 Mute enabled
x0xx xxxx	DAC7 Mute disabled
x1xx xxxx	DAC7 Mute enabled
0xxx xxxx	DAC8 Mute disabled
1xxx xxxx	DAC8 Mute enabled

DEC	HEX	B7	B6	B5	B4	B3	B2	B1	B0
69	45	ZERO8	ZERO7	ZERO6	ZERO5	ZERO4	ZERO3	ZERO2	ZERO1

ZERO[8:1] Zero flag (read-only)

These bits indicate the present status of the zero detect circuit for each DAC channel; these bits are read-only.

ZERO	Zero flag
xxxx xxx0	DAC1 zero input not detected
xxxx xxx1	DAC1 zero input detected
xxxx xx0x	DAC2 zero input not detected
xxxx xx1x	DAC2 zero input detected
xxxx x0xx	DAC3 zero input not detected
xxxx x1xx	DAC3 zero input detected
xxxx 0xxx	DAC4 zero input not detected
xxxx 1xxx	DAC4 zero input detected
xxx0 xxxx	DAC5 zero input not detected
xxx1 xxxx	DAC5 zero input detected
xx0x xxxx	DAC6 zero input not detected
xx1x xxxx	DAC6 zero input detected
x0xx xxxx	DAC7 zero input not detected
x1xx xxxx	DAC7 zero input detected
0xxx xxxx	DAC8 zero input not detected
1xxx xxxx	DAC8 zero input detected

DEC	HEX	B7	B6	B5	B4	B3	B2	B1	B0
70	46	DAMS	RSV	DEMP1	DEMP0	RSV	AZRO1	AZRO0	ZREV

DAMS **Digital attenuation mode**

This bit selects the attenuation mode.

Default value: 0.

DAMS	Digital attenuation mode
0	Fine step: 0.5-dB step for 0 dB to –63 dB range (default)
1	Wide range: 1-dB step for 0 dB to –100 dB range

RSV **Reserved**

Reserved; do not use.

DEMP[1:0] **Digital de-emphasis function/sampling rate control**

These bits are used to disable or enable the various sampling frequencies of the digital de-emphasis function.

Default value: 00.

DEMP	Digital de-emphasis function/sampling rate control
00	Disable (default)
01	48 kHz enable
10	44.1 kHz enable
11	32 kHz enable

AZRO[1:0] **Zero flag channel combination selection**

The AZRO[1:0] bits are used to select the zero flag channel combination for ZERO1 and ZERO2. If the analog mute function control by ZERO flags is used, AZRO[1:0] should not be set '00'; otherwise, analog mute works even if the data of DATA2–4 are not zero.

Default value: 00_B.

AZRO	Zero flag combination selection
00	Combination A: ZERO1 = DATA1 left channel, ZERO2 = DATA1 right channel (default)
01	Combination B: ZERO1 = DATA1–4, ZERO2 = DATA1–4
10	Combination C: ZERO1 = DATA4, ZERO2 = DATA1–3
11	Combination D: ZERO1 = DATA1, ZERO2 = DATA2–4

ZREV **Zero flag polarity selection**

This bit controls the polarity of the zero flag pin.

Default value: 0.

ZREV	Zero flag polarity selection
0	High for zero detect (default)
1	Low for zero detect

DEC	HEX	B7	B6	B5	B4	B3	B2	B1	B0
71	47	RSV	RSV	RSV	RSV	RSV	RSV	RSV	RSV
72	48	ATDA17	ATDA16	ATDA15	ATDA14	ATDA13	ATDA12	ATDA11	ATDA10
73	49	ATDA27	ATDA26	ATDA25	ATDA24	ATDA23	ATDA22	ATDA21	ATDA20
74	4A	ATDA37	ATDA36	ATDA35	ATDA34	ATDA33	ATDA32	ATDA31	ATDA30
75	4B	ATDA47	ATDA46	ATDA45	ATDA44	ATDA43	ATDA42	ATDA41	ATDA40
76	4C	ATDA57	ATDA56	ATDA55	ATDA54	ATDA53	ATDA52	ATDA51	ATDA50
77	4D	ATDA67	ATDA66	ATDA65	ATDA64	ATDA63	ATDA62	ATDA61	ATDA60
78	4E	ATDA77	ATDA76	ATDA75	ATDA74	ATDA73	ATDA72	ATDA71	ATDA70
79	4F	ATDA87	ATDA86	ATDA85	ATDA84	ATDA83	ATDA82	ATDA81	ATDA80

RSV **Reserved**

Reserved; do not use.

ATDAx[7:0] **Digital attenuation level setting**

Where *x* = 1 to 8, corresponding to the DAC output ($V_{OUT}x$).

Each DAC output ($V_{OUT}1$ through $V_{OUT}8$) has a digital attenuation function. The attenuation level can be set from 0 dB to R dB, in S-dB steps. Changes in attenuator levels are made by incrementing or decrementing one step (S dB) for every $8/f_S$ time interval until the programmed attenuator setting is reached. Alternatively, the attenuation level can be set to infinite attenuation (or mute). R (Range) and S (Step) is –63 and 0.5 for DAMS = 0 and –100 and 1.0 for DAMS = 1, respectively. The DAMS bit is defined in Register 70 (46h). Table 17 shows attenuation levels for various settings.

The attenuation level for each channel can be set individually using the following formula:

Attenuation level (dB) = S × ($ATDAx[7:0]_{DEC}$ – 255)

where $ATDAx[7:0]_{DEC}$ = 0 through 255.

For $ATDAx[7:0]_{DEC}$ = 0 through 128 with DAMS = 0 or 0 through 154 with DAMS = 1, attenuation is set to infinite attenuation (mute).

Default value: 1111 1111.

Table 17. Attenuation Levels for Various Settings

ATDAx[7:0]		ATTENUATION LEVEL SETTING	
BINARY	**DECIMAL**	**DAMS = 0**	**DAMS = 1**
1111 1111	255	0 dB, no attenuation (default)	0 dB, no attenuation (default)
1111 1110	254	–0.5 dB	–1 dB
1111 1101	253	–1.0 dB	–2 dB
...	...	...	...
1001 1100	156	–45.9 dB	–99 dB
1001 1011	155	–50.0 dB	–100 dB
1001 1010	154	–50.5 dB	Mute
...	...	...	...
1000 0010	130	–62.5 dB	Mute
1000 0001	129	–63.0 dB	Mute
0000 0000	128	Mute	Mute
...	...	...	...
0000 0000	0	Mute	Mute

APPLICATION INFORMATION

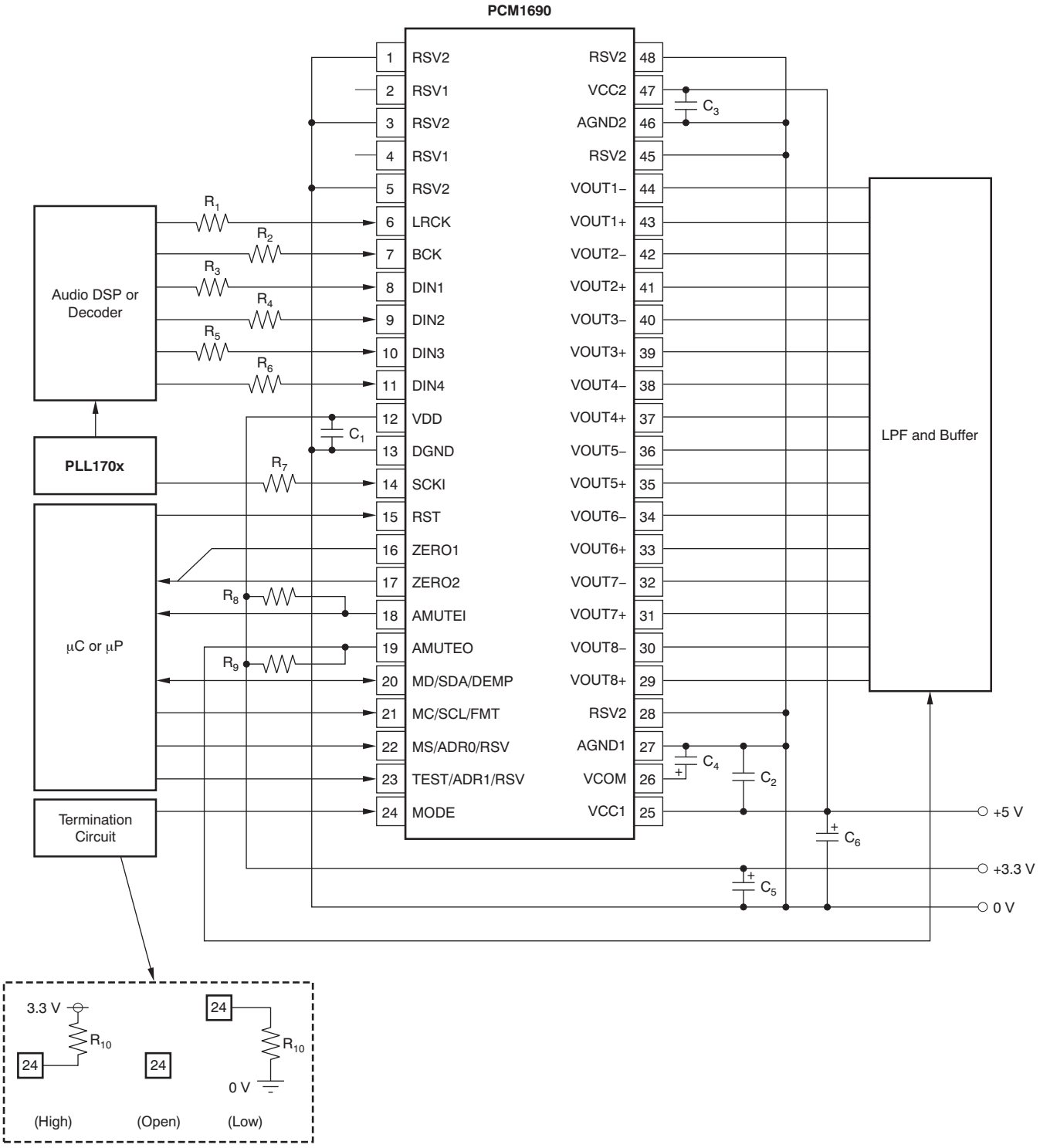
CONNECTION DIAGRAMS

A basic connection diagram is shown in Figure 40, with the necessary power-supply bypassing and decoupling components. Texas Instruments' PLL170X is used to generate the system clock input at SCKI, as well as to generate the clock for the audio signal processor. The use of series resistors (22 Ω to 100 Ω) are recommended for SCKI, LRCK, BCK, DIN1, DIN2, DIN3, and DIN4 for electromagnetic interference (EMI) reduction.

POWER SUPPLY AND GROUNDING

The PCM1690-Q1 requires +5 V for the analog supply and +3.3 V for the digital supply. The +5-V supply is used to power the DAC analog and output filter circuitry, and the +3.3-V supply is used to power the digital filter and serial interface circuitry. For best performance, it is recommended to use a linear regulator with the +5-V and +3.3-V supplies.

Five capacitors are required for supply bypassing (see Figure 40). These capacitors should be located as close as possible to the PCM1690-Q1 package. The 10-µF capacitors are aluminum electrolytic, while the three 1-µF capacitors are ceramic.



NOTE: C_1 through C_3 are 1-µF ceramic capacitors. C_4 through C_6 are 10-µF electrolytic capacitors. R_1 through R_7 are 22-Ω to 100-Ω resistors. R_8 and R_9 are resistors appropriate for pull-up. R_{10} is less than 10 kΩ.

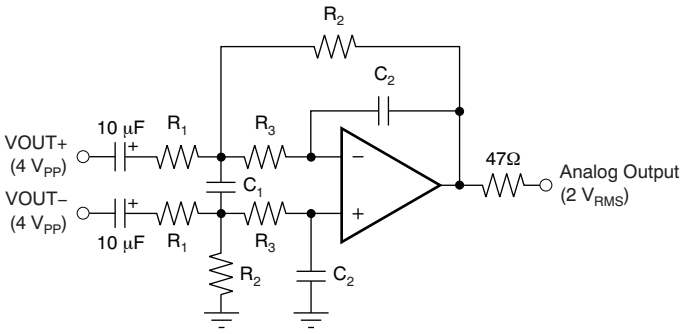
Figure 40. Basic Connection Diagram

LOW-PASS FILTER AND DIFFERENTIAL-TO-SINGLE-ENDED CONVERTER FOR DAC OUTPUTS

ΔΣ DACs use noise-shaping techniques to improve in-band signal-to-noise ratio (SNR) performance at the expense of generating increased out-of-band noise above the Nyquist frequency, or $f_S/2$. The out-of-band noise must be low-pass filtered in order to provide optimal converter performance. This filtering is accomplished by a combination of on-chip and external low-pass filters.

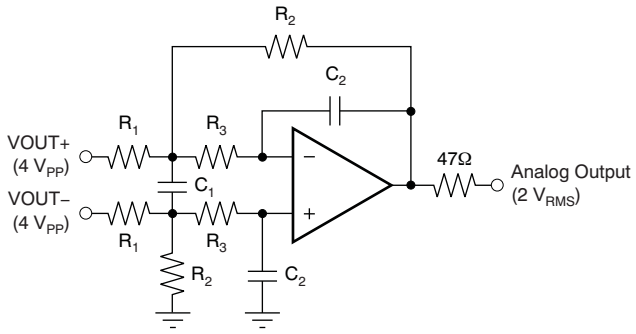
Figure 41 and Figure 42 show the recommended external differential-to-single-ended converter with low-pass active filter circuits for ac-coupled and dc-coupled applications. These circuits are second-order Butterworth filters using a multiple feedback (MFB) circuit arrangement that reduces sensitivity to passive component variations over frequency and temperature. For more information regarding MFB active filter designs, please refer to Applications Bulletin SBAA055, *Dynamic Performance Testing of Digital Audio D/A Converters*, available from the TI web site (www.ti.com) or the local Texas Instruments' sales office.

Because the overall system performance is defined by the quality of the DACs and the associated analog output circuitry, high-quality audio op amps are recommended for the active filters. Texas Instruments' OPA2134, OPA2353, and NE5532A dual op amps are shown in Figure 41 and Figure 42, and are recommended for use with the PCM1690-Q1.



NOTE: Amplifier is an NE5532A x1/2 or OPA2134 x1/2; R_1 = 7.5-kΩ; R_2 = 5.6-kΩ; R_3 = 360-Ω; C_1 = 3300-pF; C_2 = 680-pF; Gain = 0.747; $f_{-3\ dB}$ = 53 kHz.

Figure 41. AC-Coupled, Post-LPF and Differential to Single-Ended Buffer



NOTE: Amplifier is an NE5532A x1/2 or OPA2134 x1/2; R_1 = 15-kΩ; R_2 = 11-kΩ; R_3 = 820-Ω; C_1 = 1500-pF; C_2 = 330-pF; Gain = 0.733; $f_{-3\ dB}$ = 54 kHz.

Figure 42. DC-Coupled, Post-LPF and Differential to Single-Ended Buffer

PCB LAYOUT GUIDELINES

A typical printed circuit board (PCB) layout for the PCM1690-Q1 is shown in Figure 43. A ground plane is recommended, with the analog and digital sections being isolated from one another using a split or cut in the circuit board. The PCM1690-Q1 should be oriented with the digital I/O pins facing the ground plane split/cut to allow for short, direct connections to the digital audio interface and control signals originating from the digital section of the board.

Separate power supplies are recommended for the digital and analog sections of the board. This configuration prevents the switching noise present on the digital supply from contaminating the analog power supply and degrading the dynamic performance of the PCM1690-Q1.

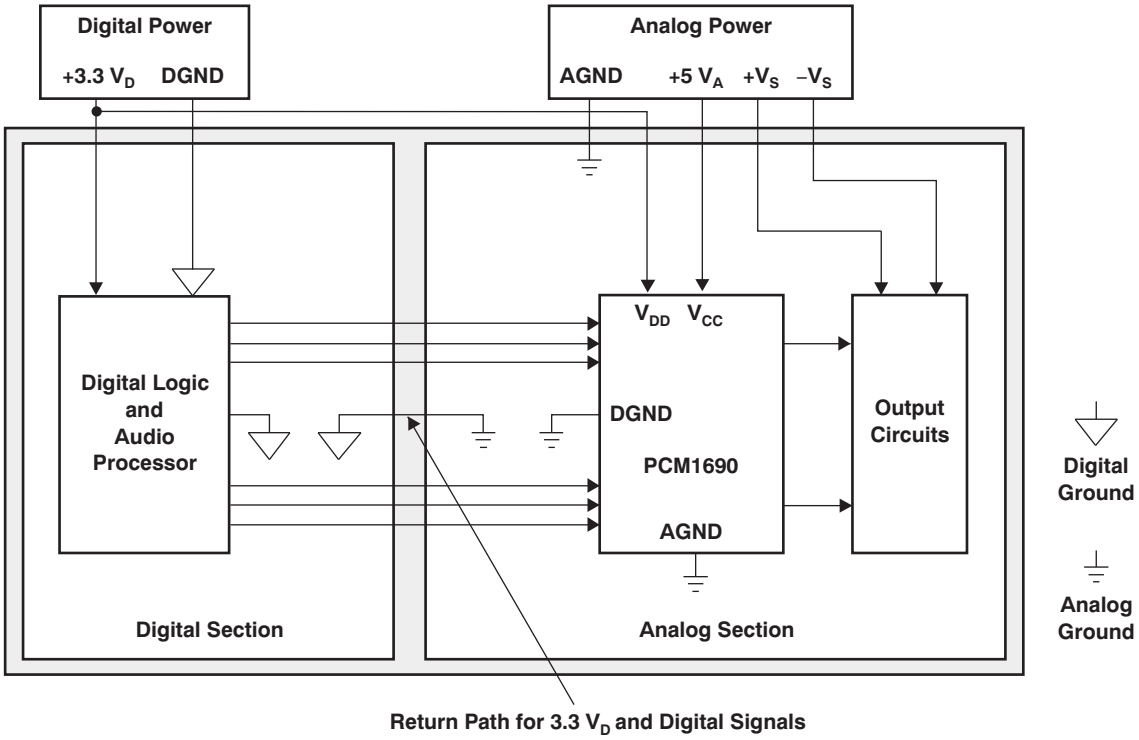


Figure 43. Recommended PCB Layout

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
PCM1690IDCARQ1	ACTIVE	HTSSOP	DCA	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	PCM1690Q	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

OTHER QUALIFIED VERSIONS OF PCM1690-Q1 :

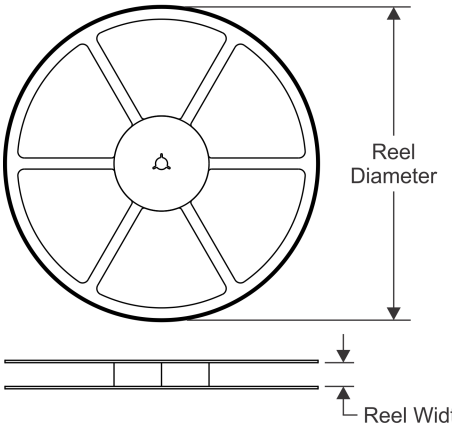
- Catalog: PCM1690

NOTE: Qualified Version Definitions:

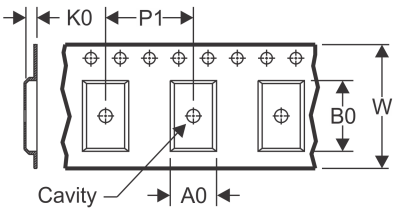
- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION

REEL DIMENSIONS

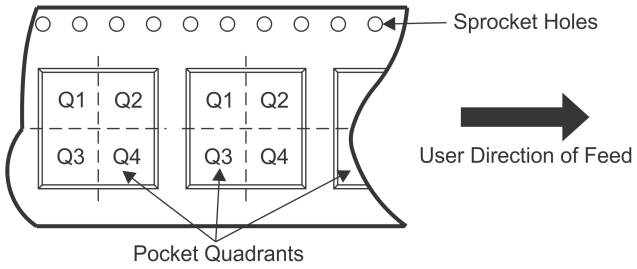


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

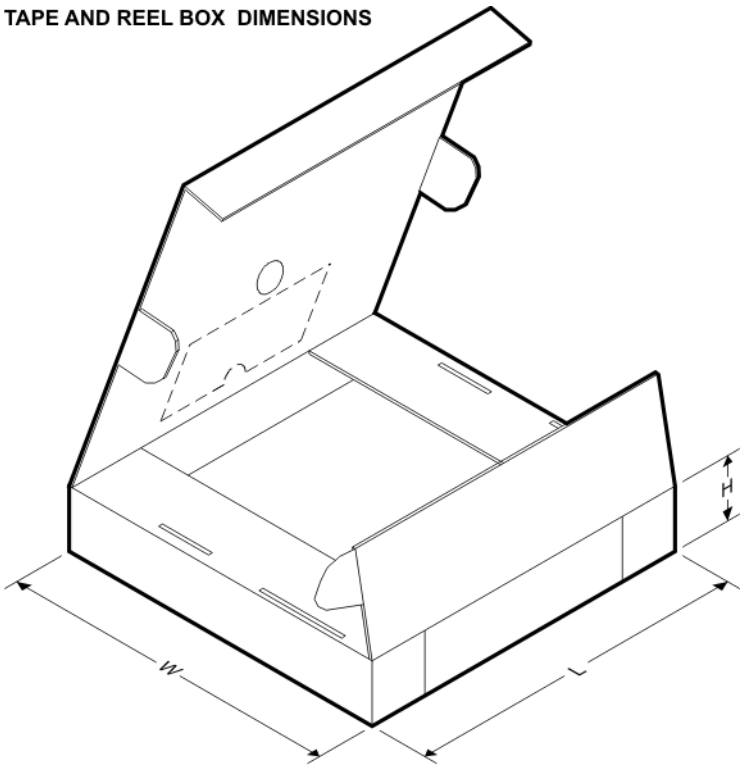
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PCM1690IDCARQ1	HTSSOP	DCA	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1

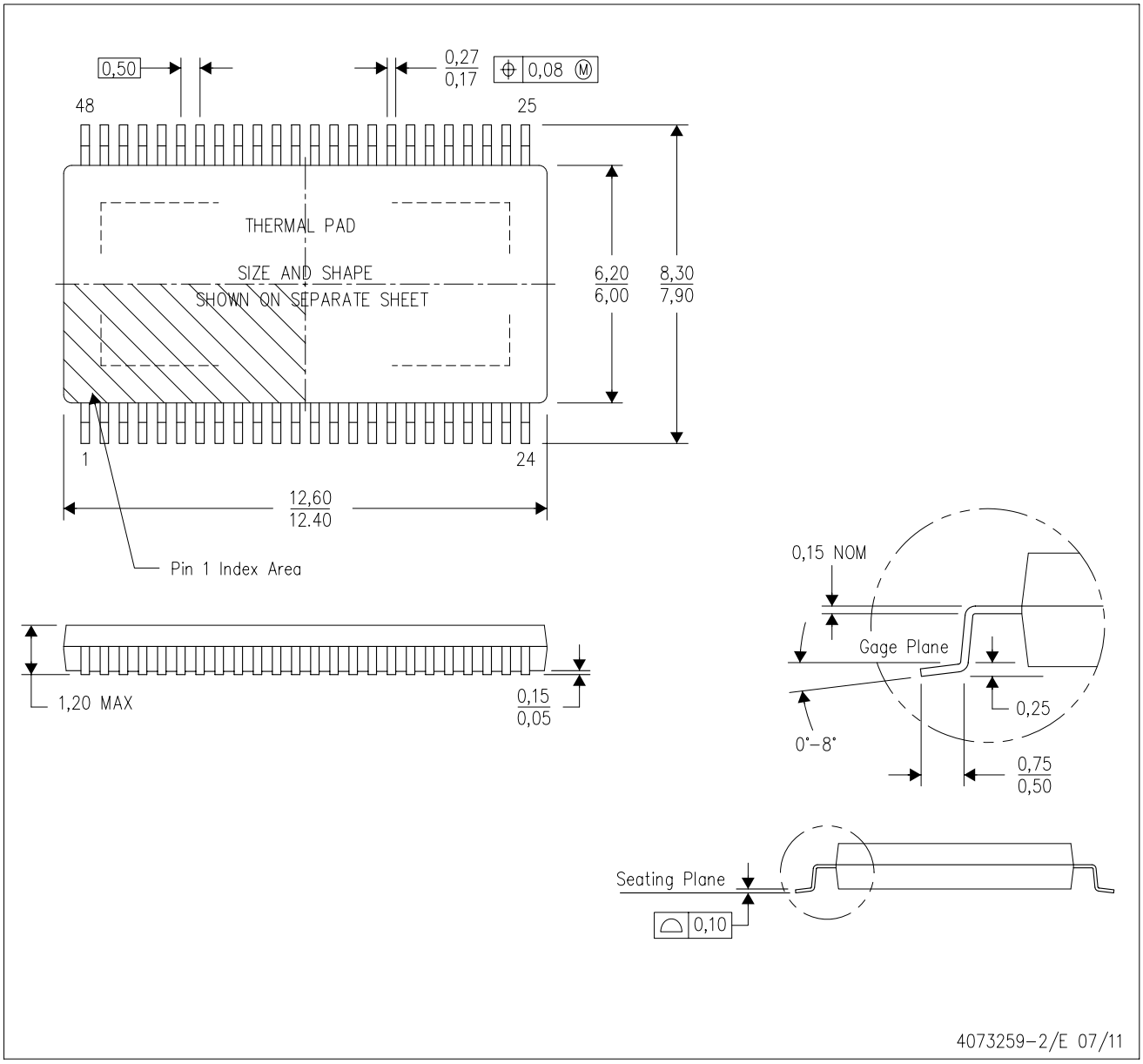
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PCM1690IDCARQ1	HTSSOP	DCA	48	2000	367.0	367.0	45.0

DCA (R–PDSO–G48) PowerPAD™ PLASTIC SMALL–OUTLINE



NOTES:
A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M–1994.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com <http://www.ti.com>.
E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
F. Falls within JEDEC MO–153

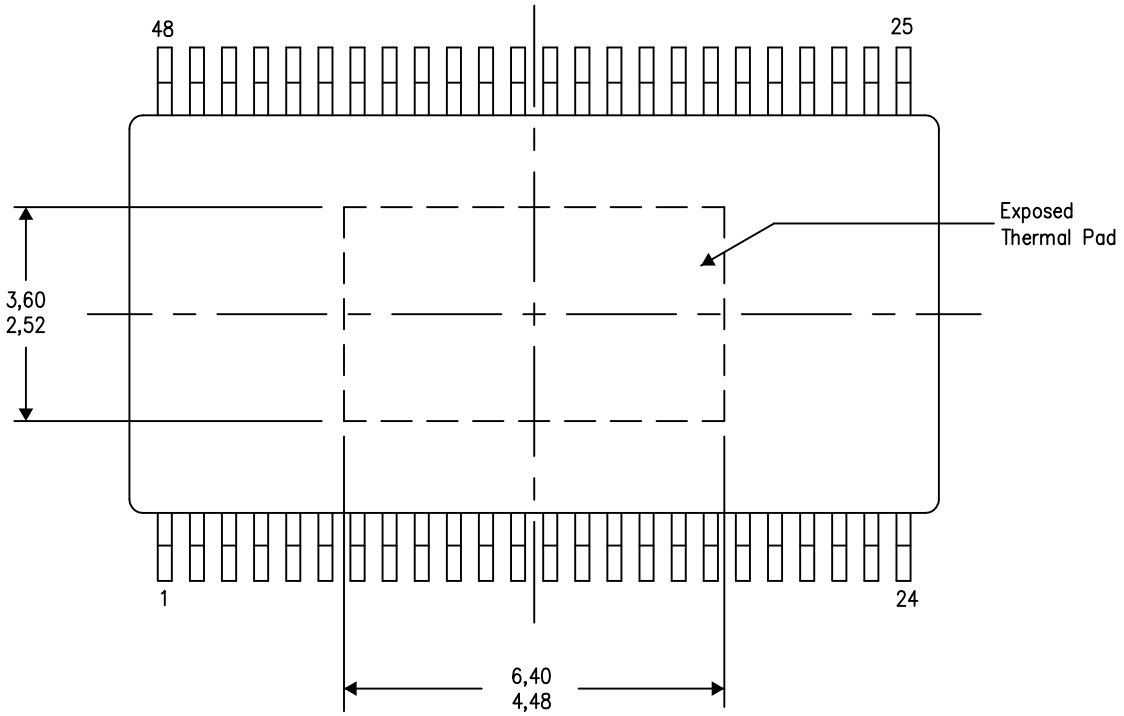
DCA (R–PDSO–G48) PowerPAD™ PLASTIC SMALL OUTLINE

THERMAL INFORMATION

This PowerPAD™ package incorporates an exposed thermal pad that is designed to be attached to a printed circuit board (PCB). The thermal pad must be soldered directly to the PCB. After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



Top View

Exposed Thermal Pad Dimensions

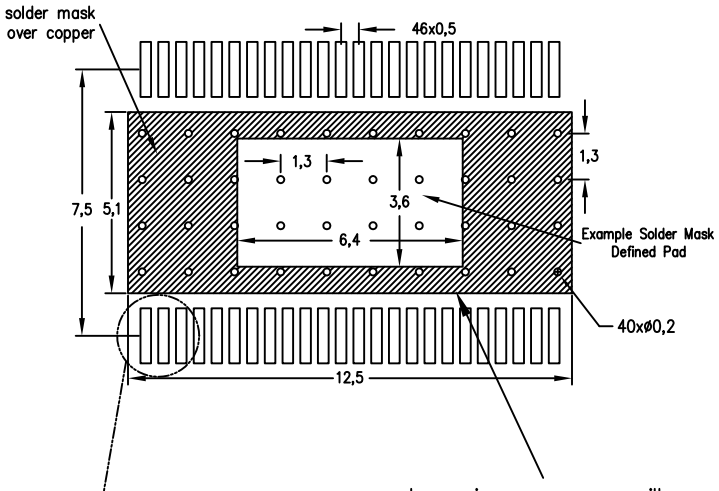
4206320–4/S 11/14

NOTE: A. All linear dimensions are in millimeters

PowerPAD is a trademark of Texas Instruments.

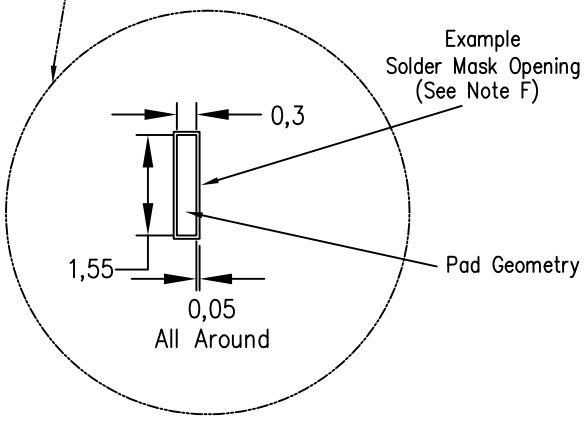
DCA (R–PDSO–G48) PowerPAD™ PLASTIC SMALL OUTLINE PACKAGE

Example Board Layout
Via pattern and copper pad size
may vary depending on layout constraints

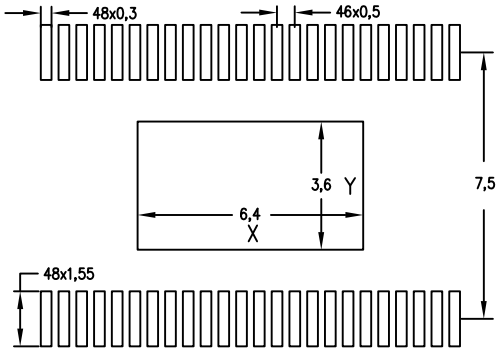


Increasing copper area will
enhance thermal performance
(See Note D)

Example
Non Soldermask Defined Pad



Stencil openings based
on a stencil thickness of .127mm
Reference table below for other
solder stencil thicknesses



(See Note E)

Center PowerPAD Solder Stencil Opening		
Stencil Thickness	X	Y
0.1mm	7.21	4.06
0.127mm	6.40	3.60
0.152mm	5.85	3.29
0.178mm	5.41	3.04

4208546–3/H 11/14

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002, SLMA004, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <http://www.ti.com>. Publication IPC–7351 is recommended for alternate designs.
E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC–7525 for other stencil recommendations.
F. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265